

Service
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Service Manual



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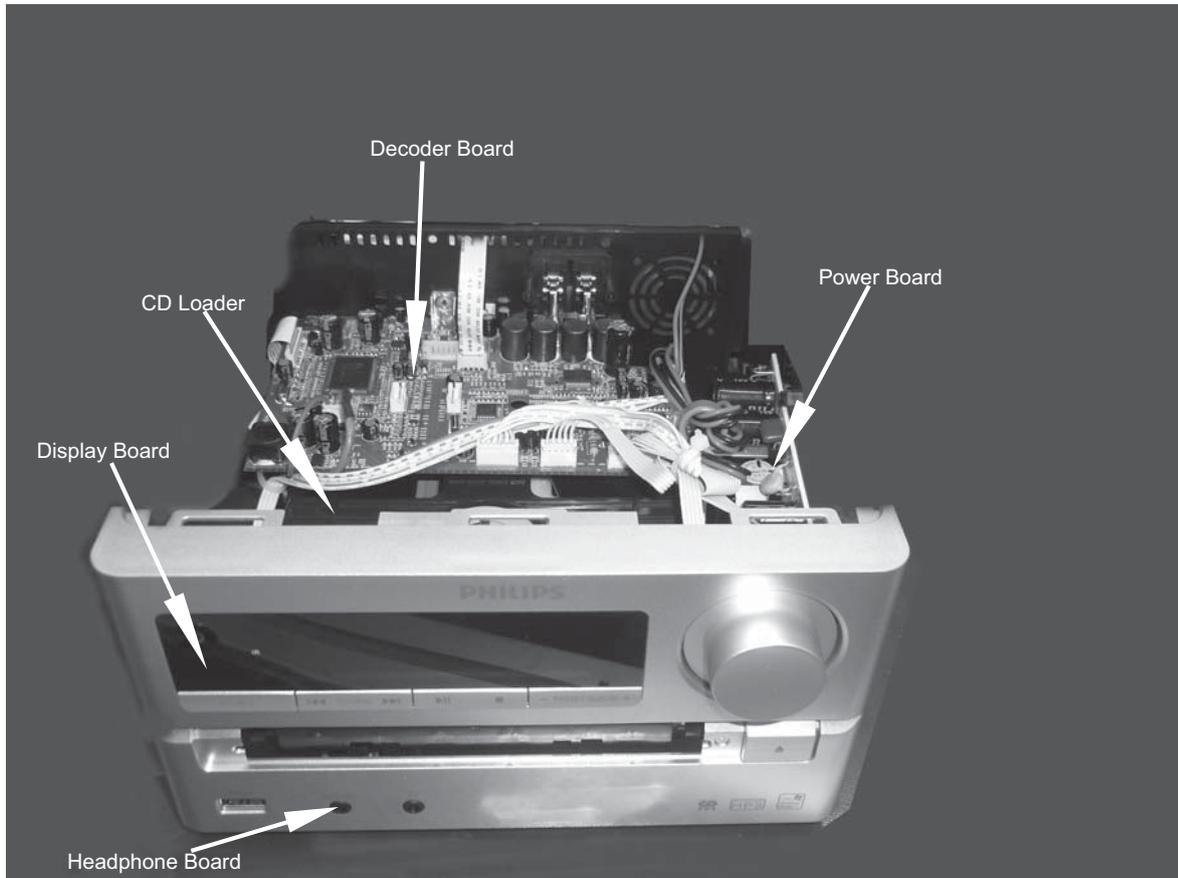
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Feature Different	/10	/12	/93	/98
RDS				
Voltage Selector				
ECO Standby		✓	✓	✓
DTS				



Technical Specification and Connection Facilities

Location of PC Boards



Version Variations

Type /Versions:		MCD2010										
Board in used:	Service policy	/10	/12	/51	/55	/58	/61	/79	/93	/94	/96	/98
Display Board			C						C			C
Headphone Board			C						C			C
Decoder Board			M						M			M
Power Board			M						M			M
Type /Versions		MCD2010										
Features	Feature difference	/10	/12	/37	/55	/58	/61	/79	/93	/94	/96	/98
RDS												
VOLTAGE SELECTOR												
ECO STANDBY - DARK			√						√			√
DTS												
* TIPS : C -- Component Lever Repair. M -- Module Lever Repair √ -- Used												

2. General Information and Requirement

2.1 Product Family Features

2.1.1 Identity and Key Features

MCD2010 series are Micro DVD Audio system,DVD/CD/MP3 play,USB,Tuner FM(20presets)

Elements to include as generic requirements:

1. Detachable mains cord
2. Safety certification (cUL/FCC and CB/EMC/CE)

Following is a list of key features:

1. DVD disc player (MTK_MT1389J)
2. USB true source
 - a) MSC/MTP device
 - b) USB High Speed
3. MP3 Link (via headphones jack from PC or MP3 player)
4. Headphone Out (in front of the set)
5. Tuner FM(Silicon Lab SI4705/w RDS)
6. Digital Amplifier
7. Rated output power @10%THD table 2

Set Type Number	Stroke Versions	Power	Remark
MCD2010	All version	2x10W	

2.1.2 Styling, Forms and Functions

MCD2010 appearances are defined in their respective MUS.MUS is the leading document where product appearance is applicable..

Features	Products	MCD2010
	Stroke versions	All
	Design	Refer to MUS[3] for details
Front	Optical Drive Loading	Tray
	Tray Location	Middle
	Tray Orientation	HORIZONTAL
	LCD	UP
Dimension	Height of feet	3mm
	Apparatus tray closed W x D x H (mm)	
Weight	Main set	
	speaker	

Technical Specification and Connection Facilities

Features	Products	MCD2010
	Stroke versions	All
Cosmetics	Color	BLACK
	Buttons	GRAY

2.1.3 External I/O Connections

Model	MCD2010
Stroke Version	All
iPod dock with Authentication chip	NA
USB	√
MP3 Link (3.5mm audio jack)	√
Composite CVBS (Yellow)	√
Component Y Pb Pr	√
Aux In (RCA cinch)	√
Aux Out (RCA cinch)	√
Tuner Socket (for FM)	√
Headphone Out (3.5mm audio jack)	√

2.1.4 Controls, Local Display and LED Indications(tbc)

Control keys on the set are:

1. Standby-On
2. Eject
3. Play/Pause
4. Next
5. Pre
6. FF
7. FB
8. Source (Disc, USB, Dock, FM, Aux, MP3)
9. Stop
10. Volume Knob

There is local display LCD(reuse DCD322 LCD). Standby LED colour: Red in Standby mode.

2.1.5 . ACCESSORIES (tbc)

Model	MCD2010
Stroke Version	All Version
Region	
Power Cord	1.8M

Technical Specification and Connection Facilities

AV cable	NA
Audio cable (3.5mm audio)	0.5M
Tuner Antenna	1.5M 75ohm
Speaker cable	3M
AV cable(Video out only)	1.5M
USB cable	NA
Remote Control	40keys
Battery	AAAx2
Quickly guide	1
IFU	1

2.2 Mechanical General Information

The product appearances and functions are defined in their respective MUS. Product management approves the MUS and it is a leading document where product appearance is applicable.

Please refer to Sh560 for mechanical information.

2.3 Safety Standards

Where applicable:

For /12 (EU), /05 (UK), /51 (Russia)

For /37 (US, Canada)

For /55 (LATAM), /78 (Brazil)

For /98 (AP), /69 (Singapore), /75 (Australia)

For /93 (China)

For /61 (Korea)

For /96 (Taiwan)

EN/IEC 60065 7th Edition

UL 60065

IEC 60065 7th Edition

IEC 60065 7th Edition

GB 8898 (IEC 60065 7th Edition)

K 60065 6th Edition

CNS 14408 (IEC 60065 7th Edition)

2.4 EMC Requirements

Where applicable:

For /12 (EU), /05 (UK), /51 (Russia)

For /37 (US, Canada)

For /55 (LATAM), /78 (Brazil)

For /98 (AP), /69 (Singapore), /75 (Australia)

For /61 (Korea)

For /93 (China)

For /96 (Taiwan)

EN55013: 2001, EN55020: 2002

FCC15

CISPR13

CISPR13

CISPR13/20

GB 13837 (CISPR13)

CNS 13439 (CISPR13)

Technical Specification and Connection Facilities

2.5 ESD Requirements

The product shall withstand electro static discharges on all user accessible parts of the product.
Reference: IEC61000-4-2.

For contact discharges:

Level	General (kV)	USA (kV)	Requirement
1	0-2	0-3	No deviations allowed.
2	>2-4	>3-4	Short perceptible deviations allowed
3	>4-5	>4-5	Normal recallable functions function changes allowed.
4	>5-7	>5-7	Control recallable functions function changes allowed.
5	-	>7-8	No loss of stored data allowed.

For air discharge:

Level	General (kV)	USA (kV)	Requirement
1	0-4	0-6	No deviations allowed.
2	>4-8	>6-8	Short perceptible deviations allowed.
3	>8-10	>8-10	Normal recallable functions function changes allowed.
4	>10-15	>10-15	Control recallable functions function changes allowed.
5	-	>15-18	No loss of stored data allowed.

General requirement:

1. 10 arcs for positive and negative polarity for unit "on" and "off" for 1kV incremental steps.
2. Component or mechanical damage is not allowed. No loss of fixed stored data (stored in EEPROMs).
3. Hang-ups and malfunctions are allowed, as long as the customer can "recover" from the hang-up by pressing the Standby or ON/OFF button of the set.
4. Failures that disappear only by unplugging the AC mains cord and/or power sources are not acceptable.

2.6 Environmental Condition

The environmental condition requirements and test method is according to UAN-D1590.

Ambient temperature : max. 40 ° C - all climates
Apparatus acc. to spec. : +5 to + 35 ° C

Vibration test (acc. IEC 60 068/2/6) : operational vibration test to be proceeded in operating position of the set.

2.7 Quality

PQR-class: class 2 according to BLC A&MA PQR handbook V2.1 (2006-10-02)

Lifetime: 7 years

Tested According to: General Test Instruction UAN-D 1591
Measured According to: UAN_L 1059 unless otherwise stated

3. Technical Specifications

3.1 Power Supply

3.1.1 Type and versions

Build-inSMPS will be used for all models and stroke versions.

All using figure '8' socket, will cater for all versions:

Versions	Region/Country	SMPS	Detachable mains cords
12 / 05	EUROPE / UK	1) 100 ~240Vac nom. (wide range from 90V~264Vac limit) used in all versions except India. Frequency: 47~63Hz.	EU (/12) round 2-pin & UK (/05) 3-pin
37	NAFTA		UL flat pin (non-polarized)
55	LATAM		INMETRO certified round 2-pin
98	APAC		EU round 2-pin
94	India	2) 100 ~310Vac limit (India compatible with up cost) used only for India. Frequency: 47~63Hz.	EU (/12) round 2-pin

All requirements per defined for each country should be met with sufficient testing.

3.1.2 Surge Immunity (Lightning Test)

The product shall withstand mains interference's of:

Differential mode:

- 2kV/2 ohm criteria C for Europe.
 - 6kV/12 ohm criteria C for NAFTA.
- Parameters:
- Bi-wave
 - Open circuit voltage: 2/50us
 - Short circuit current: 8/20us
 - From +/-1kV to +/-2kV (for Europe) or +/-6kV (for Nafta) in steps of 1kV.
 - 10 shots per combination.
 - One shot per minute.
 - Serial impedance: 2 Ohm for Europe, 12Ohm for Nafta.
 - Polarity and phase: Positive (phase 90°) & Negative (phase 270°)

Technical Specification and Connection Facilities

Common mode:

- 6kV/2 ohm criteria C for Europe.
- 6kV/12 ohm criteria C for Nafta.

Parameters:

- Ring-wave (100kHz)
- From +/3kV to +/-6kV in steps of 1 kV.
- 10 shots per combination.
- One shot per minute.
- Serial impedance: 2 Ohm for Europe, 12Ohm for Nafta
- Polarity and phase: Positive (phase 90°) & Negative (phase 270°)

Reference: IEC61000-4-5 and for USA: 3135 019 8029 Reliability evaluation.

Requirements:

- Apparatus should fulfil the leakage current requirements of IEC60065 point 9.1.1 (UAN-D1631)
- Defects or permanent deviations are not allowed.

3.1.3 Mains Drop-out Immunity

The product shall withstand mains failures of:

- Variation 0% (=100% dip) at T-event = 50 mSec. Performance criterion B
- Variation 40% (=60% dip) at T-event = 100 mSec. Performance criterion B
- Variation 0% (=100% dip) at T-event = 5 Sec. Performance criterion C

Additional for USA apparatus: See 3135 019 8029 Reliability evaluation.

- Variation 0% (=100% dip) at T-event = 100 mSec in standby mode. Performance criterion B

Requirement:

No misoperation and no interference of user in order to guarantee continuation of performed function.

Reference: IEC61000-4-11 For measuring method refer to UAN-D1724, as far as applicable.

Performance criterions according to IEC61000-4-4 Amendment 1

Performance Requirement

Criterion A - No any degradation of specification.

Criterion B - Temporary degradation / self recoverable.

Criterion C - No damage, resolvable hang-up.

Criterion D - Not recoverable loss of function.

3.1.4 Power Consumption

Power consumption at nominal AC input:

1. CD play mode at 1/8 P-rated output power

MCD2010: ≤ 10 W

2. Low Power Standby Mode

: ≤ 0.5 W

Technical Specification and Connection Facilities

3.2 Technical Description

3.2.1 Audio Performance

General Part				
Output Stage Protection:	NA	Temperature :	Yes	Short Circuit: Yes
Indicators				
Standby Mode Indicator:		Clock Display Active		
Power Standby Mode:		LED Turns Off		
Electrical Data				
			Normal	Limit
DSC:	Y	Channel Difference:	$\pm 3\text{dB}$	-
DBB:	Y	Hum (Vol_{\min} --- Vol_{\max} -20dB)	150nW	-
Bass:	NA	Residual Noise(Volume Minimum)	40nW	-
Treble:	NA	Channel Separation: 1kHz/10kHz	40dB/35dB	
Loudness:	NA	THD,Maximal	0.8%	1.0%
		Signal to Noise Ratio(A-weighted):	82dBA	77dBA
		Crosstalk:	60dB	55dB
		Amplification Reserve	3dB	2dB
Audio Inputs				
Audio Input Sensitivity($\pm 3\text{dB}$) rated output power at 1kHz			Audio Output(*1)	
Tuner	FM 67.5kHz, Modulation (Limit:-6dB)		Line Out(Left/Right)	2000mV \pm 200mV
CD/MP3	-3dB track (Audio Disc 1, Track 1)		Headphone	15mW \pm 2 dB, RL = 32 Ω
USB	-3dB 1KHz sinewave(2.0HS)			
AUX1(back)	1V; Rin \geq 22k Ω			
MP3_link(front)	750mV; Rin \geq 22k Ω			
IPOD Docking	750mV; Rin \geq 22k Ω			
Output Power(*1)	At THD=10%, 1kHz sinewave	MCD2010		
Main Operation for / all version (rms)		10W \pm 1dB		(At Cold Condition with 10% THD)
Tuner output power(rms)		10W \pm 1dB		(At Cold Condition with 10% THD)
Frequency Response($\pm 3\text{dB}$)		30Hz-20kHz		
Loudspeaker(Boxes): Separable speaker box	Refer to package document of Speaker Box Assy			
Speaker driver Impedance: Right/Left:	6 Ω @ 30 Hz ~ 20kHz(-3db)			
Subwoofer:				

REMARKS:

Electrical Parameters are to be measured at Speaker Terminals across rated impedance Load(6ohm) with Rated Input Signal in CD Mode setting in DBB/Loudness Off and Pre-eq at Flat unless specified otherwise.

Technical Specification and Connection Facilities

3.2.2 Video Performance

3.2.2.1 CVBS

Description	Test Signal	Specification	
		NTSC	PAL
Amplitude output	100% White	1Vpp ± 10%	1Vpp ± 10%
White bar	100% White	714mV ± 10%	700mV ± 10%
Sync. Amplitude	100% White	286mV ± 10%	300mV ± 10%
Burst Amplitude	75% Color bar	286mV, +1dB / -4dB	300mV, +1dB / -4dB
Burst / chroma ratio	100% Color bar	± 5%	± 5%
S/N luminance	100% White	≥ 60 dB	≥ 60 dB
S/N chroma	100% Red	≥ 57 dB	≥ 60 dB
	AM PM	≥ 57 dB	≥ 57 dB
Video Bandwidth	Multi-burst		+1dB/-1dB
	0.5MHz – 4MHz		-2dB
	4.8MHz	-1.5dB	-5dB
	5.8MHz	-5dB	
Chroma Subcarrier Frequency	75% Color bar	3.579545 MHz ± 25ppm	4.433618MHz ± 30ppm
Chroma / luminance delay	2T pulse	≤ 20ns	≤ 20ns
Subcarrier locked/unlocked	75% Color bar	locked	locked
DC Level	0% Black	≤ 1V	≤ 1V

3.2.2.2 Component Video (Y/Pb/Pr)

Description	Test Signal	Specification	
		NTSC	PAL
		Interlace/Progressive	
		NTSC	PAL
Amplitude output	100% White	1000mV ± 10%	1000mV ± 10%
White bar	100% White	714mV ± 10%	700mV ± 10%
PbPr peak to peak	75% Color bar	525mV ± 10%	535mV ± 10%
PbPr Output unbalance	75% Color bar	≤ 3%	≤ 3%
Sync. Amplitude	100% White	286mV ± 40mV	300mV ± 10%
S/N on outputs	100% White	≥ 60 dB	≥ 60 dB
	Y Pb / Pr	75% Color bar	
Video Bandwidth	Multi-burst		-1.5dB
	4.2MHz	-1.5dB	-5dB
	5.8MHz	-5dB	
Video Bandwidth (Progressive)	Multi-burst		-1.5dB
	8.4MHz	-1.5dB	-5dB
	9.6MHz	-5dB	
DC Level	0% Black	≤ 1V	≤ 1V

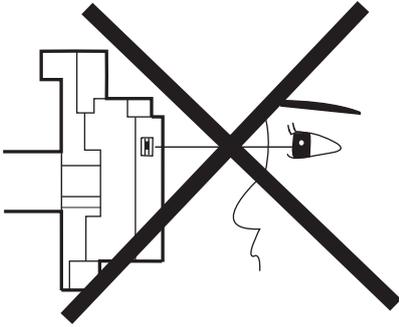
Technical Specification and Connection Facilities

3.3 TUNER

FM use Silicon Lab Si4704/4705(w/RDS)							
GENERAL PART							
WAVE RANGE	VERSION	TOLERANCE	TUNING GRID				
FM 87.5 – 108.00 MHz	/12	QUARTZ PRECISION	50kHz				
AERIAL							
FM : PIG TAIL ANT WIRE 75Ω							
ELECTRICAL DATA							
				FM	Nom	Limit	Unit
				- 3 dB Limiting Point	20	26	dBf
				Search Tuning Sensitivity(at stereo mode)	35	41	
				Search time digital tuning system.	-	60	s
				IF	10.7		MHz
				Stereo - 46 dB Quieting	48	51	dB
				Modulation Hum	50	45	
				S/N Ratio	50	45	
				Amplification Reverse	0	-4	dB
				Distortion (RF 1mV, Frq Dev.75 kHz)	2	3	%
				Overall Frequency Response: 63Hz – 12.5KHz	-	±3	dB
				Channel separation:400 / 1000 / 5000 Hz. RF input: 68 dBf	26/30/20	20/26/18	dB
Frequency (MHz)		Noise Limited Sensitivity 26 dB	Image Rejection	IF Rejection	Large Signal Handling	Selectivity S9/300 kHz	
FM	Nom.	18	30	64	1000	22	
88.0	Lim.	22	25	45	500	18 (*1)	
FM	Nom.	18	30	64	1000	22	
98.0	Lim.	22	25	45	500	18 (*1)	
FM	Nom.	18	30	60	116 dBf	45	
107.0	Lim.	22	25	65	108 dBf	25	
Units		dBf	DB	dB	mV/m	dB	
Susceptibility to unwanted signals(CPU,SMPS,AMP,DSP ...):			Limited(dB)	Normal (dB)	Remark		
			-15dB	-20dB	Refer to selfpollution curve		

Laser Beam Safety Precautions

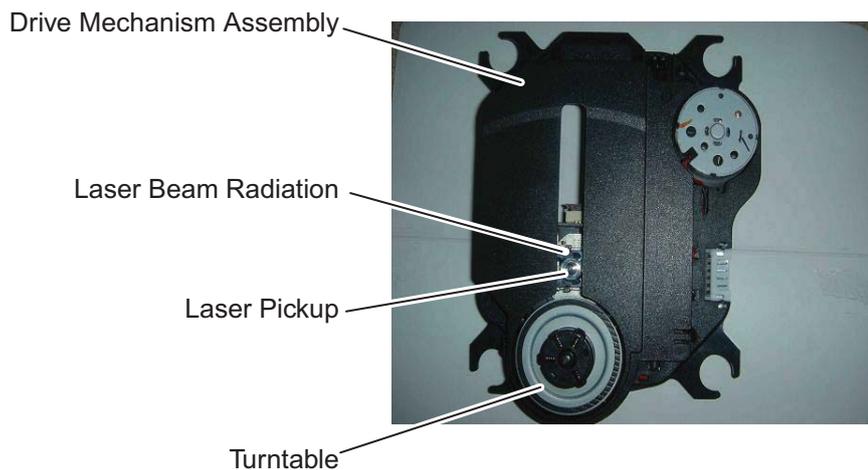
This Blu-Ray player uses a pickup that emits a laser beam.



Do not look directly at the laser beam coming from the pickup or allow it to strike against your skin.

The laser beam is emitted from the location shown in the figure. When checking the laser diode, be sure to keep your eyes at least 30 cm away from the pickup lens when the diode is turned on. Do not look directly at the laser beam.

CAUTION: Use of controls and adjustments, or doing procedures other than those specified herein, may result in hazardous radiation exposure.



CAUTION-CLASS 2M LASER
RADIATION WHEN OPEN
DO NOT STARE INTO THE BEAM
OR VIEW DIRECTLY WITH
OPTICAL INSTRUMENTS



Location: Inside Top of Blu-Ray mechanism.

Important Safety Precautions

Caution: These servicing instructions are for use by qualified service personnel only. To reduce the risk of electric shock do not perform any servicing other than that contained in the operating instructions unless you are qualified to do so.

Important

Read and understand all instructions before you use your home theater. If damage is caused by failure to follow instructions, the warranty does not apply.

Safety

Risk of electric shock or fire!

- Never expose the product and accessories to rain or water. Never place liquid containers, such as vases, near the product. If liquids are spilt on or into the product, disconnect it from the power outlet immediately. Contact Philips Consumer Care to have the product checked before use.
- Never place the product and accessories near naked flames or other heat sources, including direct sunlight.
- Never insert objects into the ventilation slots or other openings on the product.
- Where the mains plug or an appliance coupler is used as the disconnect device, the disconnect device shall remain readily operable.
- Disconnect the product from the power outlet before lightning storms.
- When you disconnect the power cord, always pull the plug, never the cable.

Risk of short circuit or fire!

- Before you connect the product to the power outlet, ensure that the power voltage matches the value printed on the back or bottom of the product. Never connect the product to the power outlet if the voltage is different.

Risk of injury or damage to the home theater!

- For wall-mountable products, use only the supplied wall mount bracket. Secure the wall mount to a wall that can support the combined weight of the product and the wall mount. Koninklijke Philips Electronics N.V. bears no responsibility for improper wall mounting that results in accident, injury or damage.

- For speakers with stands, use only the supplied stands. Secure the stands to the speakers tightly. Place the assembled stands on flat, level surfaces that can support the combined weight of the speaker and stand.
- Never place the product or any objects on power cords or on other electrical equipment.
- If the product is transported in temperatures below 5°C, unpack the product and wait until its temperature matches room temperature before connecting it to the power outlet.
- Visible and invisible laser radiation when open. Avoid exposure to beam.
- Do not touch the disc optical lens inside the disc compartment.

Risk of overheating!

- Never install this product in a confined space. Always leave a space of at least four inches around the product for ventilation. Ensure curtains or other objects never cover the ventilation slots on the product.

Risk of contamination!

- Do not mix batteries (old and new or carbon and alkaline, etc.).
- Remove batteries if they are exhausted or if the remote control is not to be used for a long time.
- Batteries contain chemical substances, they should be disposed of properly.

Product care

- Do not insert any objects other than discs into the disc compartment.
- Do not insert warped or cracked discs into the disc compartment.
- Remove discs from the disc compartment if you are not using the product for an extended period of time.
- Only use microfiber cloth to clean the product.

Important Safety Precautions

Disposal of your old product and batteries



Your product is designed and manufactured with high quality materials and components, which can be recycled and reused.



When this crossed-out wheeled bin symbol is attached to a product it means that the product is covered by the European Directive 2002/96/EC. Please inform yourself about the local separate collection system for electrical and electronic products.

Please act according to your local rules and do not dispose of your old products with your normal household waste.

Correct disposal of your old product helps to prevent potential negative consequences for the environment and human health.



Your product contains batteries covered by the European Directive 2006/66/EC, which cannot be disposed with normal household waste.

Please inform yourself about the local rules on separate collection of batteries because correct disposal helps to prevent negative consequences for the environmental and human health.

Safety Check after Servicing

Examine the area surrounding the repaired location for damage or deterioration. Observe that screws, parts, and wires have been returned to their original positions. Afterwards, do the following tests and confirm the specified values to verify compliance with safety standards.

1. Clearance Distance

When replacing primary circuit components, confirm specified clearance distance (d) and (d') between soldered terminals, and between terminals and surrounding metallic parts. (See Fig. 1)

Table 1: Ratings for selected area

AC Line Voltage	Clearance Distance (d), (d')
110V~220V	≥ 3.2 mm (0.126 inches)

Note: This table is unofficial and for reference only. Be sure to confirm the precise values.

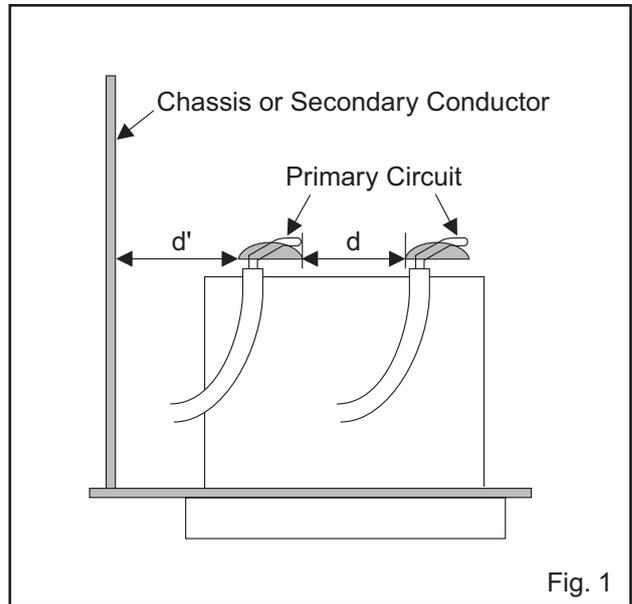


Fig. 1

2. Leakage Current Test

Confirm the specified (or lower) leakage current between B (earth ground, power cord plug prongs) and externally exposed accessible parts (RF terminals, antenna terminals, video and audio input and output terminals, microphone jacks, earphone jacks, etc.) is lower than or equal to the specified value in the table below.

Measuring Method (Power ON):

Insert load Z between B (earth ground, power cord plug prongs) and exposed accessible parts. Use an AC voltmeter to measure across the terminals of load Z. See Fig. 2 and the following table.

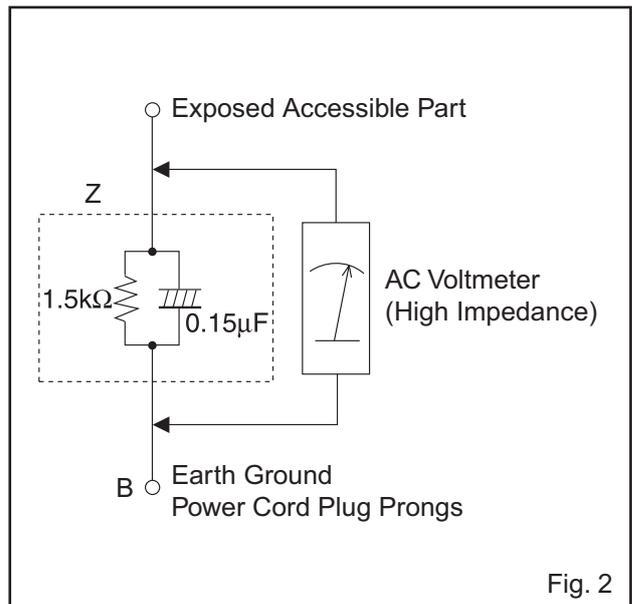


Fig. 2

Table 2: Leakage current ratings for selected areas

AC Line Voltage	Load Z	Leakage Current (i)	Earth Ground (B) to:
110V~220V	0.15 μF CAP. & 1.5 kΩ RES. Connected in parallel	$i \leq 0.5 \text{ mA Peak}$	Exposed accessible parts

Note: This table is unofficial and for reference only. Be sure to confirm the precise values.

Safety Information, General Notes & Lead Free Requirements

1 Safety Instructions

1.1 General Safety

- Safety regulations require that during a repair:
- Connect the unit to the mains via an isolation transformer.
 - Replace safety components, indicated by the symbol  , only by components identical to the original ones. Any other component substitution (other than original type) may increase risk of fire or electrical shock hazard.

Safety regulations require that after a repair, you must return the unit in its original condition. Pay, in particular, attention to the following points:

- Route the wires/cables correctly, and fix them with the mounted cable clamps.
- Check the insulation of the mains lead for external damage.
- Check the electrical DC resistance between the mains plug and the secondary side:
 1. Unplug the mains cord, and connect a wire between the two pins of the mains plug.
 2. Set the mains switch to the 'on' position (keep the mains cord unplugged!).
 3. Measure the resistance value between the mains plug and the front panel, controls, and chassis bottom.
 4. Repair or correct unit when the resistance measurement is less than 1 MΩ.
 5. Verify this, before you return the unit to the customer/user (ref. UL-standard no. 1492).
 6. Switch the unit 'off', and remove the wire between the two pins of the mains plug.

1.2 Laser Safety

This unit employs a laser. Only qualified service personnel may remove the cover, or attempt to service this device (due to possible eye injury).

Laser Device Unit

Type	: AlGaInN(BD) : AlGaInP(DVD) : AlGaInP(CD)
Wavelength	: 650 nm (DVD) : 780 nm (VCD/CD) : 405nm(BD)
Output Power	: 20 mW (DVD+RW writing) : 0.8 mW (DVD reading) : 0.3 mW (VCD/CD reading)
Beam divergence	: 60 degree



Figure 2-1

Note: Use of controls or adjustments or performance of procedure other than those specified herein, may result in hazardous radiation exposure. Avoid direct exposure to beam.

2 Warnings

2.1 General

- All ICs and many other semiconductors are susceptible to electrostatic discharges (ESD, ). Careless handling during repair can reduce life drastically. Make sure that, during repair, you are at the same potential as the mass of the set by a wristband with resistance. Keep components and tools at this same potential. Available ESD protection equipment:
 - Complete kit ESD3 (small tablemat, wristband, connection box, extension cable and earth cable) 4822 310 10671.
 - Wristband tester 4822 344 13999.
- Be careful during measurements in the live voltage section. The primary side of the power supply, including the heatsink, carries live mains voltage when you connect the player to the mains (even when the player is 'off!'). It is possible to touch copper tracks and/or components in this unshielded primary area, when you service the player. Service personnel must take precautions to prevent touching this area or components in this area. A 'lightning stroke' and a stripe-marked printing on the printed wiring board, indicate the primary side of the power supply.
- Never replace modules, or components, while the unit is 'on'.

2.2 Laser

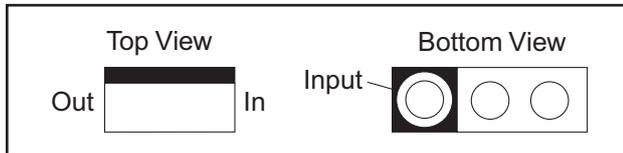
- The use of optical instruments with this product, will increase eye hazard.
- Only qualified service personnel may remove the cover or attempt to service this device, due to possible eye injury.
- Repair handling should take place as much as possible with a disc loaded inside the player.
- Text below is placed inside the unit, on the laser cover shield:

CAUTION VISIBLE AND INVISIBLE LASER RADIATION WHEN OPEN AVOID EXPOSURE TO BEAM
 ADVARSEL SYNLIG OG USYNLIG LASERSTRÅLING VED ÅBNING UNDGÅ UDSÆTTELSE FOR STRÅLING
 ADVARSEL SYNLIG OG USYNLIG LASERSTRÅLING NÅR DEKSEL ÅPNES UNNGÅ EKSPONERING FOR STRÅLEN
 VARNING SYNLIG OCH OSYNLIG LASERSTRÅLNING NÅR DENNA DEL ÅR ÖPPNAD BETRÄKTA EJ STRÅLEN
 VAROJ AVATTAESSA OLET ALTIINA NÄKYVÄLLE JA NÄKYMÄTTÖMÄLLE LASER SÄTEILYLLE. ÄLÄ KATSO SÄTEESEEN
 VORSICHT SICHTBARE UND UNSICHTBARE LASERSTRAHLUNG WENN ABDECKUNG GEÖFFNET NICHT DEM STRAHL AUSSETZEN
 DANGER VISIBLE AND INVISIBLE LASER RADIATION WHEN OPEN AVOID DIRECT EXPOSURE TO BEAM
 ATTENTION RAYONNEMENT LASER VISIBLE ET INVISIBLE EN CAS D'OUVERTURE EXPOSITION DANGEREUSE AU FAISCEAU

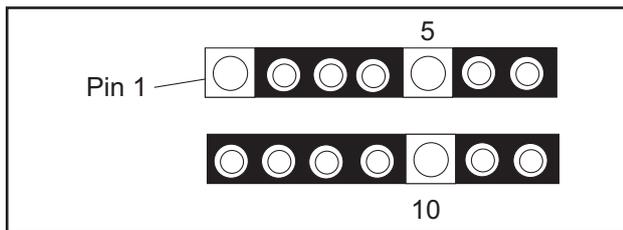
Figure 2-2

Circuit Board Indications

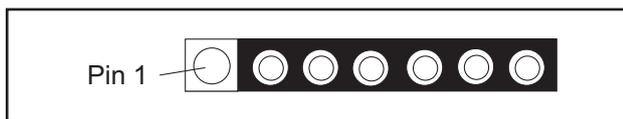
1. The output pin of the 3 pin Regulator ICs is indicated as shown.



2. For other ICs, pin 1 and every fifth pin are indicated as shown.

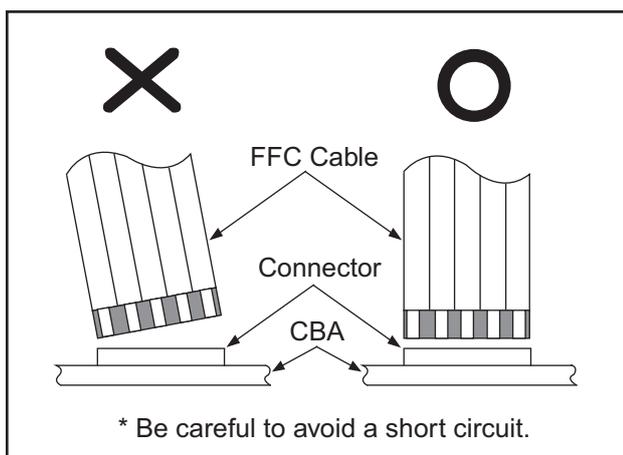


3. The 1st pin of every male connector is indicated as shown.



Instructions for Connectors

1. When you connect or disconnect the FFC (Flexible Foil Connector) cable, be sure to first disconnect the AC cord.
2. FFC (Flexible Foil Connector) cable should be inserted parallel into the connector, not at an angle.



Pb (Lead) Free Solder

When soldering, be sure to use the Pb free solder.

Information about lead-free soldering

Philips CE is producing lead-free sets from 1.1.2005 onwards.

IDENTIFICATION

Regardless of special logo (not always indicated)



One must treat all sets from **1 Jan 2005**

onwards, according to the next rule:

Serial Number gives a 14-digit. Digit 5&6 shows the YEAR, and digit 7&8 shows the WEEK.

So from **0501** onwards=from 1 Jan 2005 onwards

Important note : In fact also products of year 2004 must be treated in this way as long as you avoid mixing solder-alloys (leaded/ lead-free). So best to always use SAC305 and the higher temperatures belong to this.

Due to lead-free technology some rules have to be respected by the workshop during a repair:

- Use only lead-free solder alloy Philips SAC305 with order code 0622 149 00106. If lead-free solder-paste is required, please contact the manufacturer of your solder-equipment. In general use of solder-paste within workshops should be avoided because paste is not easy to store and to handle.
- Use only adequate solder tools applicable for lead-free solder alloy. The solder tool must be able
 - To reach at least a solder-temperature of 400°C,
 - To stabilize the adjusted temperature at the solder-tip
 - To exchange solder-tips for different applications.
- Adjust your solder tool so that a temperature around **360°C - 380°C** is reached and stabilized at the solder joint. Heating-time of the solder-joint should not exceed ~ 4 sec. Avoid temperatures above 400°C otherwise wear-out of tips will rise drastically and flux-fluid will be destroyed. To avoid wear-out of tips switch off un-used equipment, or reduce heat.
- Mix of lead-free solder alloy / parts with leaded solder alloy / parts is possible but PHILIPS recommends strongly to avoid mixed solder alloy types (leaded and lead-free).
If one cannot avoid or does not know whether product is lead-free, clean carefully the solder-joint from old solder alloy and re-solder with new solder alloy (SAC305).
- Use only original spare-parts listed in the Service-Manuals. Not listed standard-material (commodities) has to be purchased at external companies.

Standard Notes for Servicing, Lead Free Requirements & Handling Flat Pack IC

- Special information for BGA-ICs:

- always use the 12nc-recognizable soldering temperature profile of the specific BGA (for desoldering always use the lead-free temperature profile, in case of doubt)
- lead free BGA-ICs will be delivered in so-called 'dry-packaging' (sealed pack including a silica gel pack) to protect the IC against moisture. After opening, dependent of MSL-level seen on indicator-label in the bag, the BGA-IC possibly still has to be baked dry. (MSL=Moisture Sensitivity Level). This will be communicated via AYS-website. Do not re-use BGAs at all.

- For sets produced before 1.1.2005 (except products of 2004), containing leaded solder-alloy and components, all needed spare-parts will be available till the end of the service-period. For repair of such sets nothing changes.

- On our website www.atyourservice.ce.Philips.com you find more information to:

- BGA-de-/soldering (+ baking instructions)
- Heating-profiles of BGAs and other ICs used in Philips-sets

You will find this and more technical information within the "magazine", chapter "workshop news".

For additional questions please contact your local repair-helpdesk.

How to Remove / Install Flat Pack-IC

1. Removal

With Hot-Air Flat Pack-IC Desoldering Machine:

1. Prepare the hot-air flat pack-IC desoldering machine, then apply hot air to the Flat Pack-IC (about 5 to 6 seconds). (Fig. S-1-1)

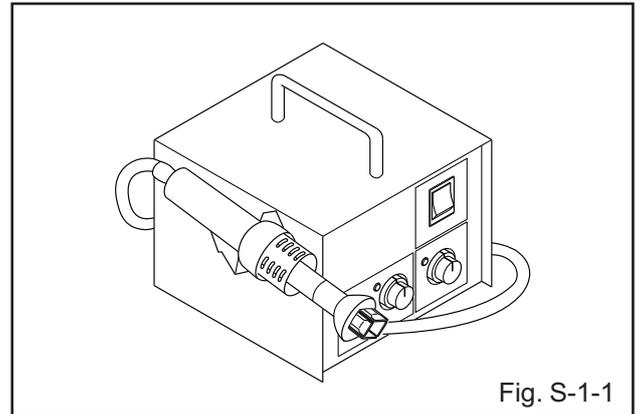


Fig. S-1-1

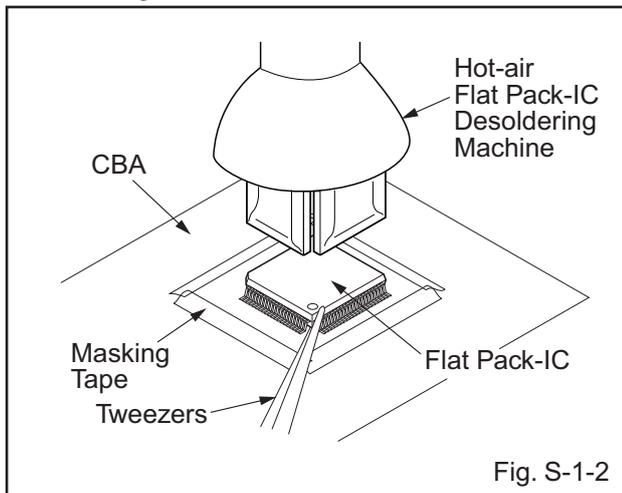
2. Remove the flat pack-IC with tweezers while applying the hot air.
3. Bottom of the flat pack-IC is fixed with glue to the CBA; when removing entire flat pack-IC, first apply soldering iron to center of the flat pack-IC and heat up. Then remove (glue will be melted). (Fig. S-1-6)
4. Release the flat pack-IC from the CBA using tweezers. (Fig. S-1-6)

CAUTION:

1. The Flat Pack-IC shape may differ by models. Use an appropriate hot-air flat pack-IC desoldering machine, whose shape matches that of the Flat Pack-IC.
2. Do not supply hot air to the chip parts around the flat pack-IC for over 6 seconds because damage to the chip parts may occur. Put masking tape around the flat pack-IC to protect other parts from damage. (Fig. S-1-2)

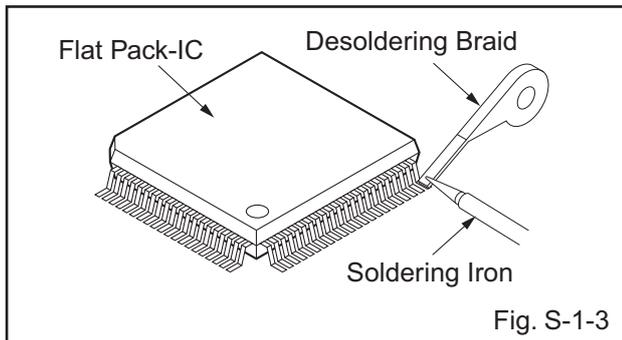
Standard Notes for Servicing, Lead Free Requirements & Handling Flat Pack IC

- The flat pack-IC on the CBA is affixed with glue, so be careful not to break or damage the foil of each pin or the solder lands under the IC when removing it.

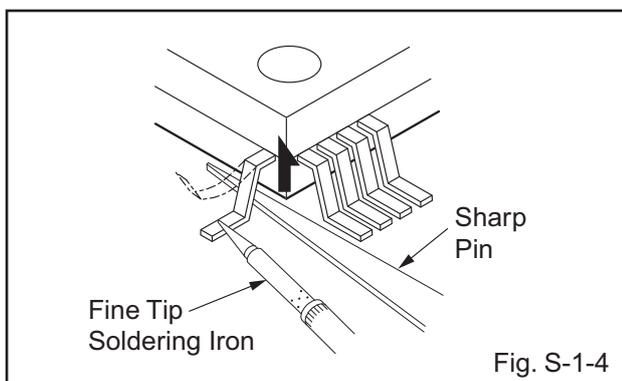


With Soldering Iron:

- Using desoldering braid, remove the solder from all pins of the flat pack-IC. When you use solder flux which is applied to all pins of the flat pack-IC, you can remove it easily. (Fig. S-1-3)



- Lift each lead of the flat pack-IC upward one by one, using a sharp pin or wire to which solder will not adhere (iron wire). When heating the pins, use a fine tip soldering iron or a hot air desoldering machine. (Fig. S-1-4)



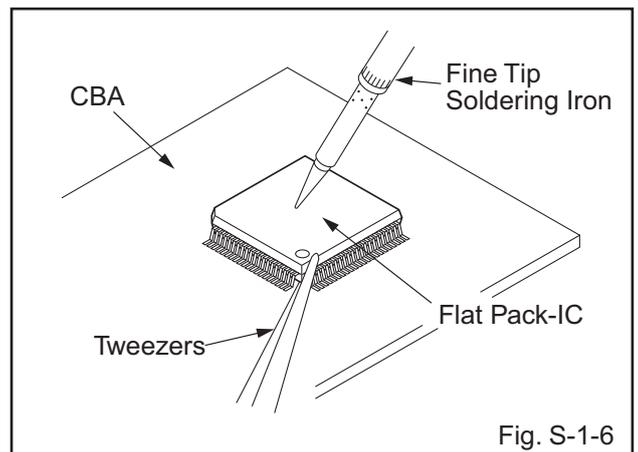
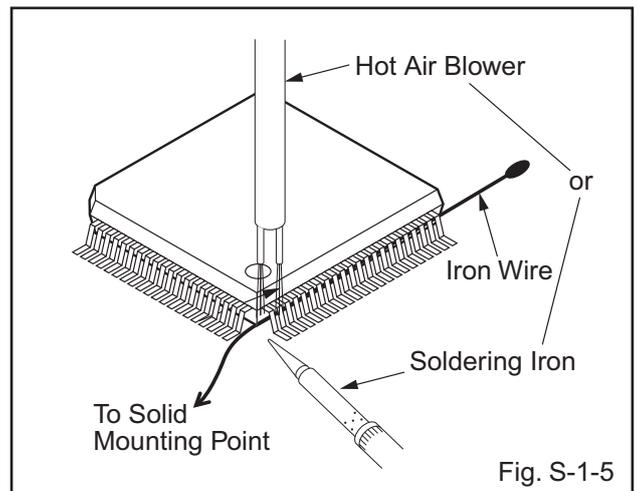
- Bottom of the flat pack-IC is fixed with glue to the CBA; when removing entire flat pack-IC, first apply soldering iron to center of the flat pack-IC and heat up. Then remove (glue will be melted). (Fig. S-1-6)

- Release the flat pack-IC from the CBA using tweezers. (Fig. S-1-6)

With Iron Wire:

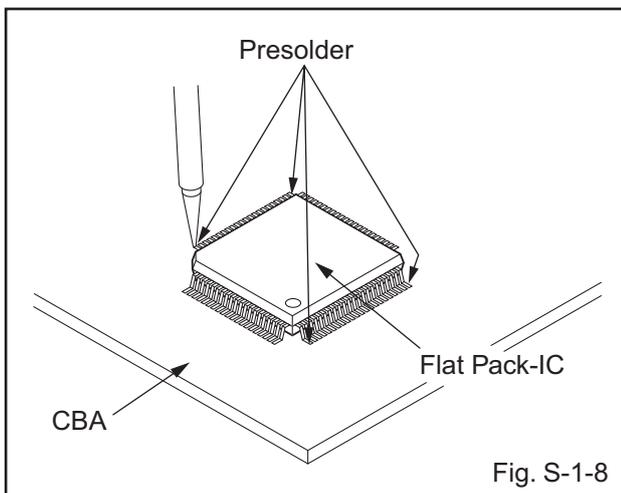
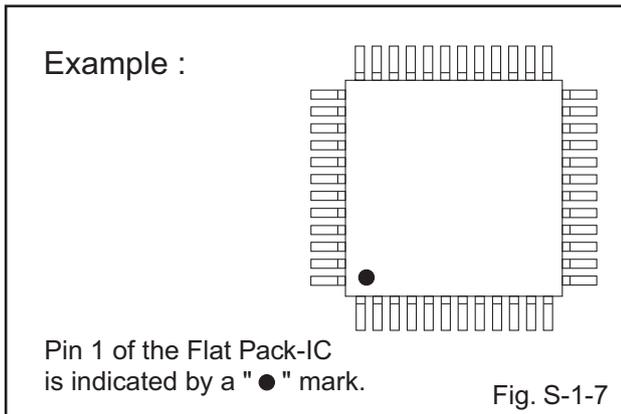
- Using desoldering braid, remove the solder from all pins of the flat pack-IC. When you use solder flux which is applied to all pins of the flat pack-IC, you can remove it easily. (Fig. S-1-3)
- Affix the wire to a workbench or solid mounting point, as shown in Fig. S-1-5.
- While heating the pins using a fine tip soldering iron or hot air blower, pull up the wire as the solder melts so as to lift the IC leads from the CBA contact pads as shown in Fig. S-1-5.
- Bottom of the flat pack-IC is fixed with glue to the CBA; when removing entire flat pack-IC, first apply soldering iron to center of the flat pack-IC and heat up. Then remove (glue will be melted). (Fig. S-1-6)
- Release the flat pack-IC from the CBA using tweezers. (Fig. S-1-6)

Note: When using a soldering iron, care must be taken to ensure that the flat pack-IC is not being held by glue. When the flat pack-IC is removed from the CBA, handle it gently because it may be damaged if force is applied.



2. Installation

1. Using desoldering braid, remove the solder from the foil of each pin of the flat pack-IC on the CBA so you can install a replacement flat pack-IC more easily.
2. The "●" mark on the flat pack-IC indicates pin 1. (See Fig. S-1-7.) Be sure this mark matches the 1 on the PCB when positioning for installation. Then presolder the four corners of the flat pack-IC. (See Fig. S-1-8.)
3. Solder all pins of the flat pack-IC. Be sure that none of the pins have solder bridges.



Instructions for Handling Semi-conductors

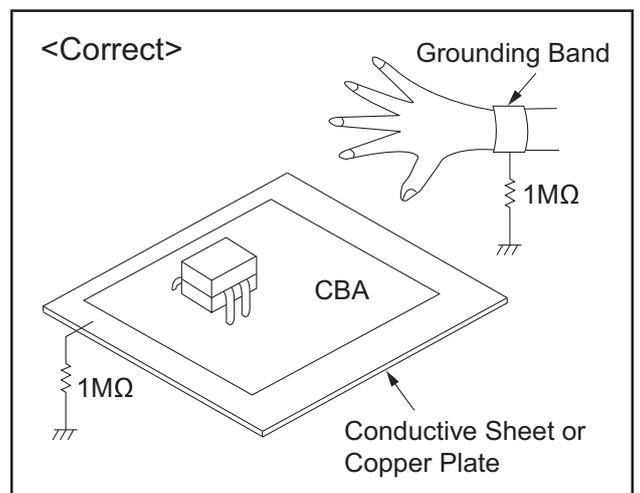
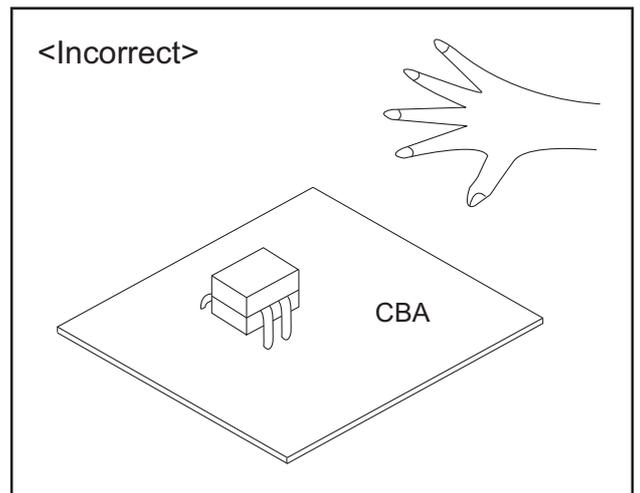
Electrostatic breakdown of the semi-conductors may occur due to a potential difference caused by electrostatic charge during unpacking or repair work.

1. Ground for Human Body

Be sure to wear a grounding band (1 MΩ) that is properly grounded to remove any static electricity that may be charged on the body.

2. Ground for Workbench

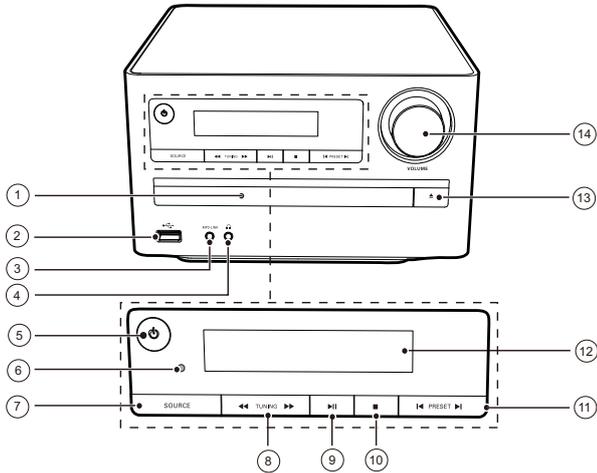
Be sure to place a conductive sheet or copper plate with proper grounding (1 MΩ) on the workbench or other surface, where the semi-conductors are to be placed. Because the static electricity charge on clothing will not escape through the body grounding band, be careful to avoid contacting semi-conductors with your clothing.



Direction of Use

*The following excerpt of the DFU/QSG serves as an introduction to the set. The Complete Direction for Use can be download in different languages from the internet site of Philips Customer care Center : www.support.philips.com

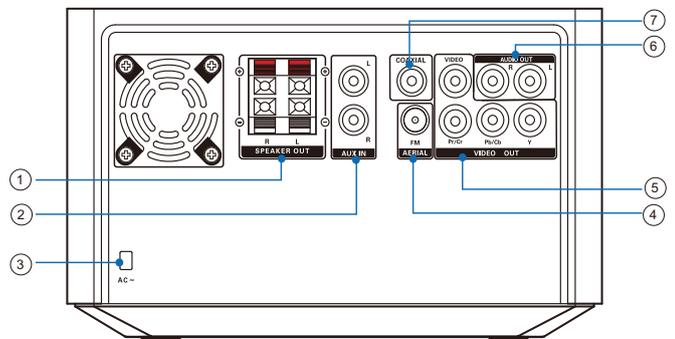
Overview of the main unit



- ① Disc compartment
 - Hold the disc.
- ②
 - USB socket.
- ③ MP3 LINK
 - Connect external audio device.
- ④
 - Headphone socket.
- ⑤
 - Turn on the apparatus, switch to standby mode, or Eco Power standby mode.
- ⑥ IR sensor
 - Detect signals from the remote control. Always point the remote control at the IR sensor.
- ⑦ SOURCE
 - Select a source.
- ⑧
 - Rotate a photo.
 - Fast backward or forward.
- ⑨
 - Start or pause play.
- ⑩
 - Stop play.
 - Erase a program.
- ⑪
 - Skip to the previous/next track, title, or file.
 - Select a programmed radio station.

- ⑫ Display panel
 - Show current status.
- ⑬
 - Open or close the disc tray.
- ⑭ VOLUME
 - Adjust volume.
 - Adjust time.

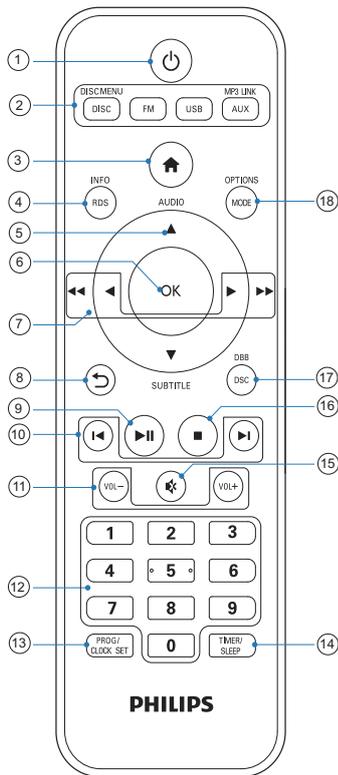
Back view



- ① SPEAKER OUT
 - Connect the speakers.
- ② AUX-IN
 - Connect an external audio device.
- ③ AC MAIN~
 - Connected with AC power cord.
- ④ FM AERIAL
 - Improve FM reception.
- ⑤ VIDEO OUT
 - Video output jack.
- ⑥ AUDIO OUT L/R
 - Audio output jack.
- ⑦ COAXIAL
 - Coaxial jack.

Direction of Use

Overview of remote control



- ①
 - Switch the micro system on/off.
- ② DISC/DISC MENU/FM/USB/AUX/MP3 LINK
 - Select the source.
- ③
 - Access the home menu.
- ④ RDS/INFO
 - Show the disk information such as title, chapter, time elapsed, total time etc.
 - Show the information of RDS stations (if available).
- ⑤ ▲ AUDIO / ▼ SUBTITLE
 - For menus: navigate up/down.
 - Invert a picture.
 - ▲ AUDIO: Toggle between stereo and mono.
 - ▼ SUBTITLE Select a subtitle language for a video.
- ⑥ OK
 - Confirm a selection.
- ⑦ ◀◀ / ▶▶
 - Search in a track or disc.
 - Fast backward or forward.
 - For menus, navigate left/right.
 - Rotate a picture.
 - Adjust time.

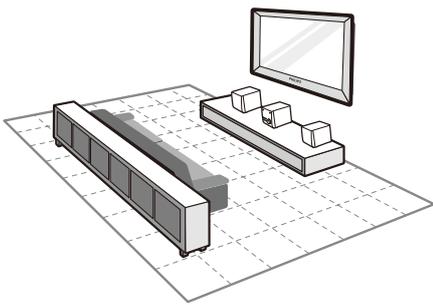
- ⑧
 - Return to a previous display menu.
- ⑨
 - Start, pause or resume play.
- ⑩ ◀ / ▶
 - Skip to the previous/next track, title, or file.
 - Select a programmed radio station.
- ⑪ VOL +/-
 - Adjust the volume.
- ⑫ Numeric buttons
 - Select a title/chapter/track to play.
- ⑬ PROG/CLOCK SET
 - Program radio stations.
 - Set clock.
- ⑭ TIMER/SLEEP
 - Set sleep timer.
 - Set alarm timer.
- ⑮
 - Mute.
- ⑯
 - Stop play.
 - Erase a programmed radio station.
 - Activate/deactivate the demonstration mode.
- ⑰ DSC/DBB
 - Select a preset sound setting.
 - Turn on or off dynamic bass enhancement.
- ⑱ MODE/OPTIONS
 - Select repeat play or random play.
 - Accesses options relating to the current activity or selection.

3 Before use

Place the unit

Note

- Risk of overheating! Never install this apparatus in a confined space. Always leave a space of at least 4 inches around this apparatus for ventilation. Ensure curtains or other objects never cover the ventilation slots on this apparatus.
- Place this unit on a flat, hard, and stable surface.
- Never place this unit in an enclosed cabinet, nor on any other electrical equipment.
- Do not insert any object other than indicated into ventilation openings nor other openings.
- Install this unit near the AC outlet where the AC power plug can be easily reached.
- To avoid magnetic interference or unwanted noise, never place the main unit and speakers too close to any radiation devices.

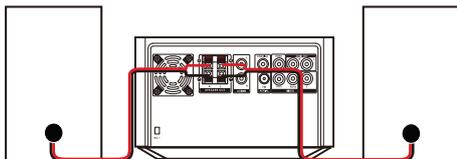


- 1 Place the unit near to the TV.
- 2 Place the speakers at a suitable distance from the TV and at an angle of approximately 45 degrees from the listening position.

Connect

Connect speakers

- 1 Insert the speaker wires completely into the speaker input sockets on the back of the unit.



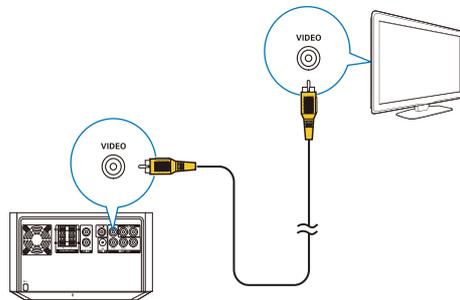
Note

- For optimal sound, use the supplied speakers only.
- Connect only speakers with impedance that is the same or higher than the supplied speakers. Refer to the Specifications section of this manual.

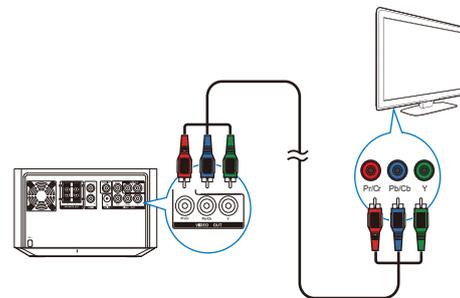
Connect TV

Connect the audio and video cables to the output sockets on the unit and the corresponding input sockets on your TV. Select the best video connection that your TV supports.

Connect through a composite video cable



Option 2: Connect through component video cables



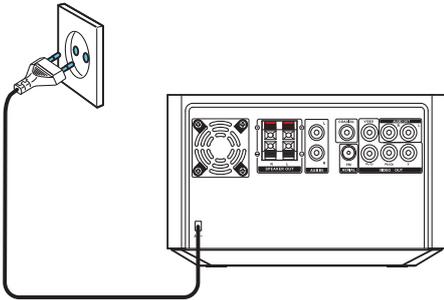
Connect a progressive scan TV through component video cables for higher quality video.

Connect power

Caution

- Risk of product damage! Ensure that the power supply voltage corresponds to the voltage printed on the back or the underside of the unit.
- Risk of electric shock! When you unplug the AC power cord, always pull the plug from the socket. Never pull the cord.
- Before you connect the AC power cord, ensure that you have completed all other connections.

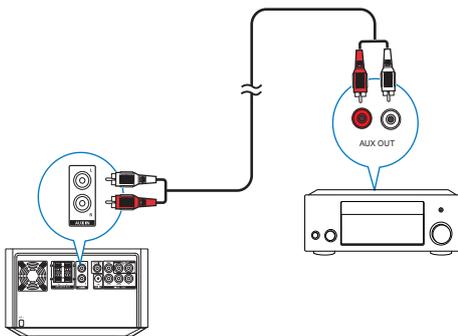
- 1 Connect the power cable to the wall socket.



You can route audio from an external device to this product.

Connect an audio cable to:

- the AUX IN L/R sockets on this product.
- the audio output sockets on the external device (for example, audio player).



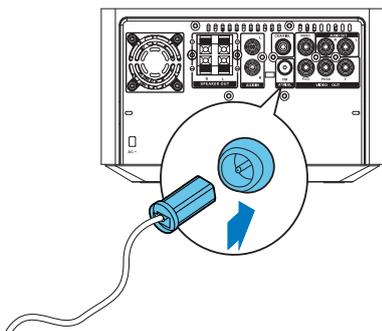
Connect FM aerial



Tip

- For optimal reception, fully extend and adjust the position of the antenna.
- For better FM stereo reception, connect an outdoor FM antenna to the FM AERIAL socket.
- The unit does not support MW radio reception.

- 1 Connect the supplied FM antenna to the FM AERIAL socket on the main unit.



Cabinet Disassembly Instructions

1. Disassembly Flowchart

This flowchart indicates the disassembly steps to gain access to item(s) to be serviced. When reassembling, follow the steps in reverse order. Bend, route, and dress the cables as they were originally.

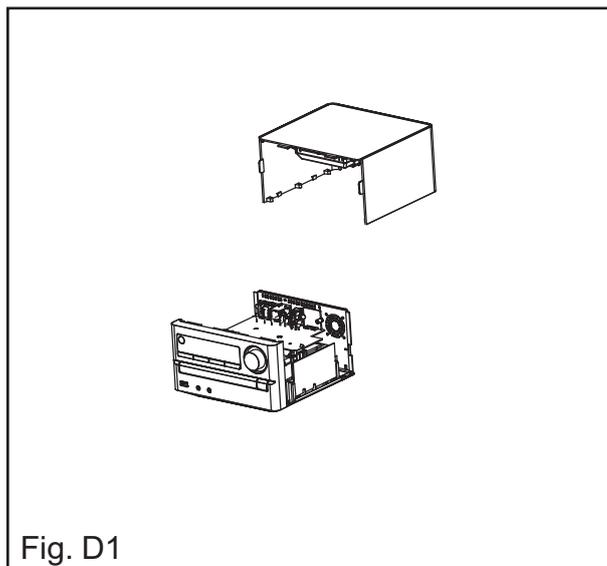
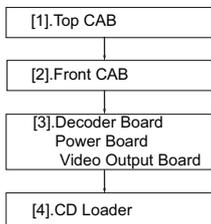


Fig. D1

2. Disassembly Method

ID/Loc. NO.	Part	Removal		
		Fig.NO.	Remove/Unhook /Unlock/Release/ Unplug/Desolder	Note
[1]	Top CAB	D1		
[2]	Front CAB	D2		
[3]	Decoder Board Power Board Video Output Board	D3		
[4]	CD Loader	D4		

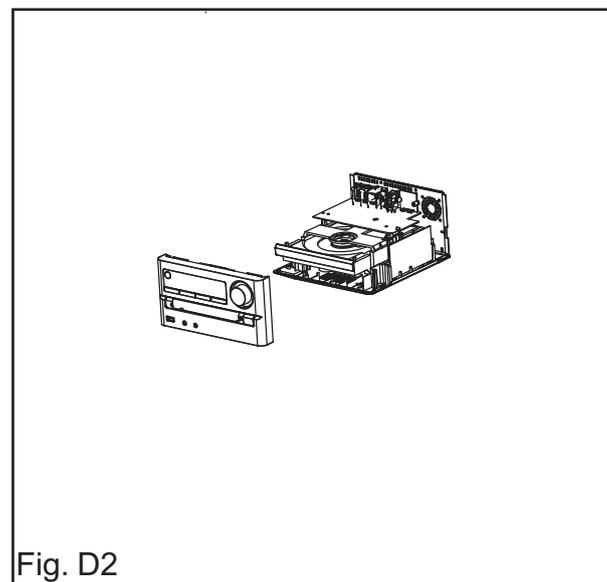


Fig. D2

Note:

- (1) Identification (location) No. of parts in the figures
- (2) Name of the part
- (3) Figure Number for reference
- (4) Identification of parts to be removed, unhooked, unlocked, released, unplugged, unclamped, or desoldered.

Axx = Screw, CNxx/Jxx/CONxx = Connector
 D3.5X12BA is specification of screw.

* = Unhook, Unlock, Release, Unplug, or Desolder
 e.g. 7(A01) = seven Screws

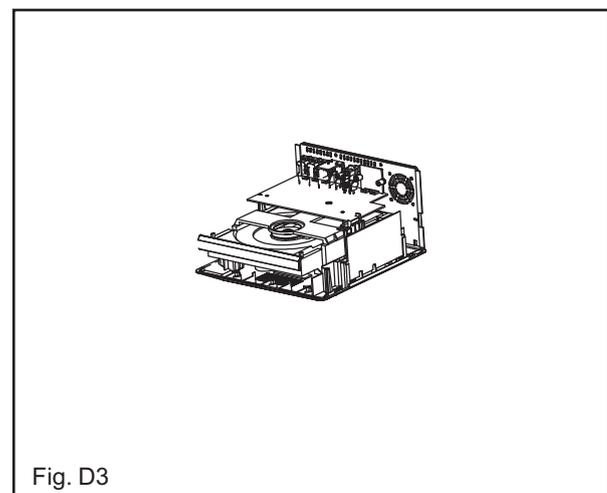
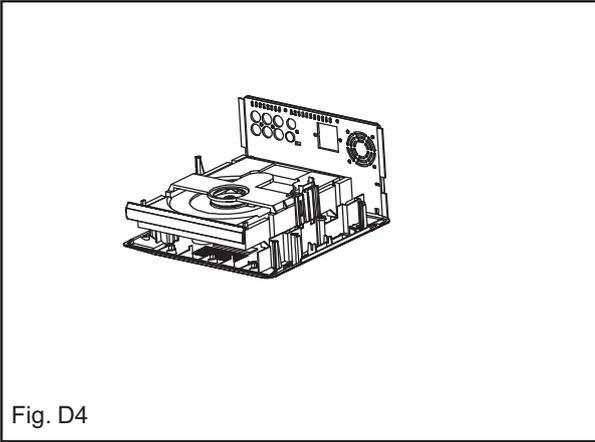


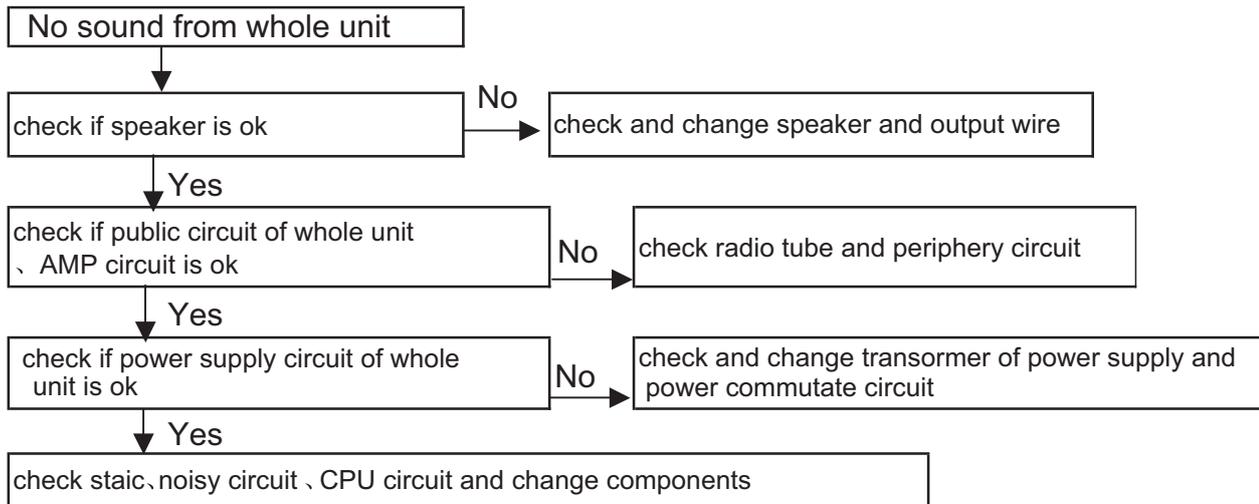
Fig. D3

Cabinet Disassembly Instructions

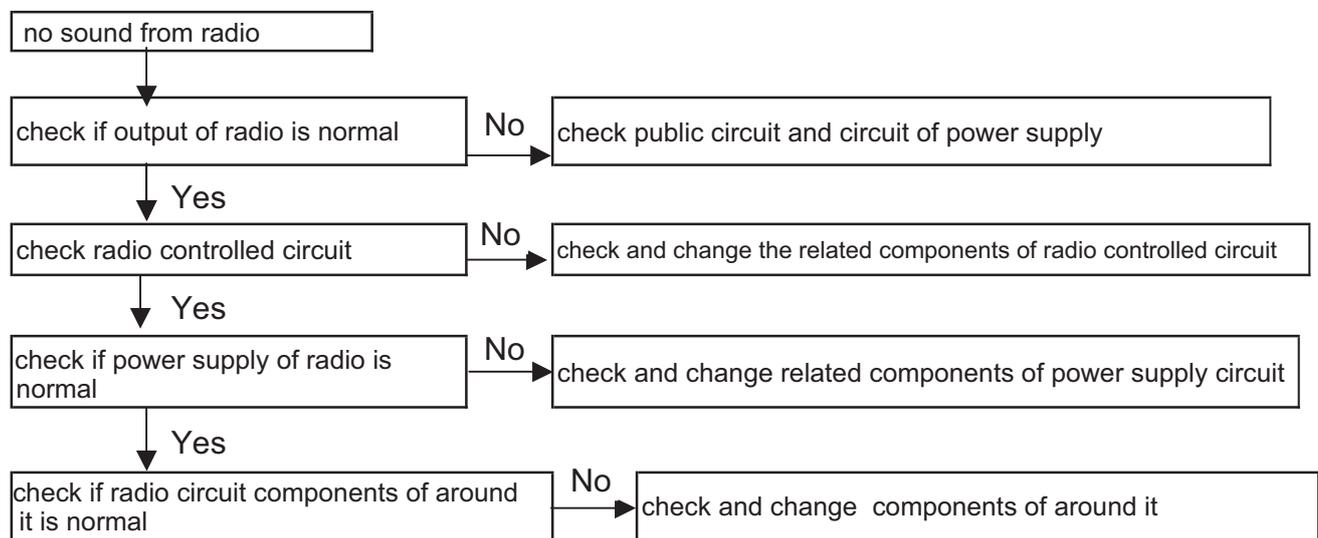


Troubleshooting

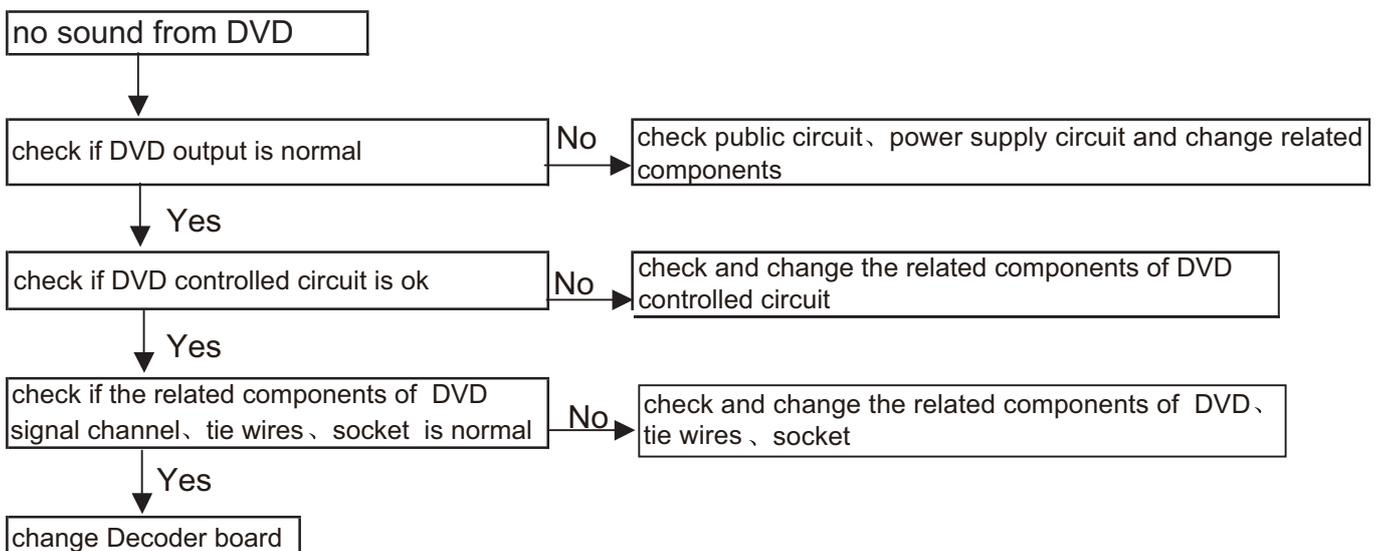
FLOW CHART NO.1



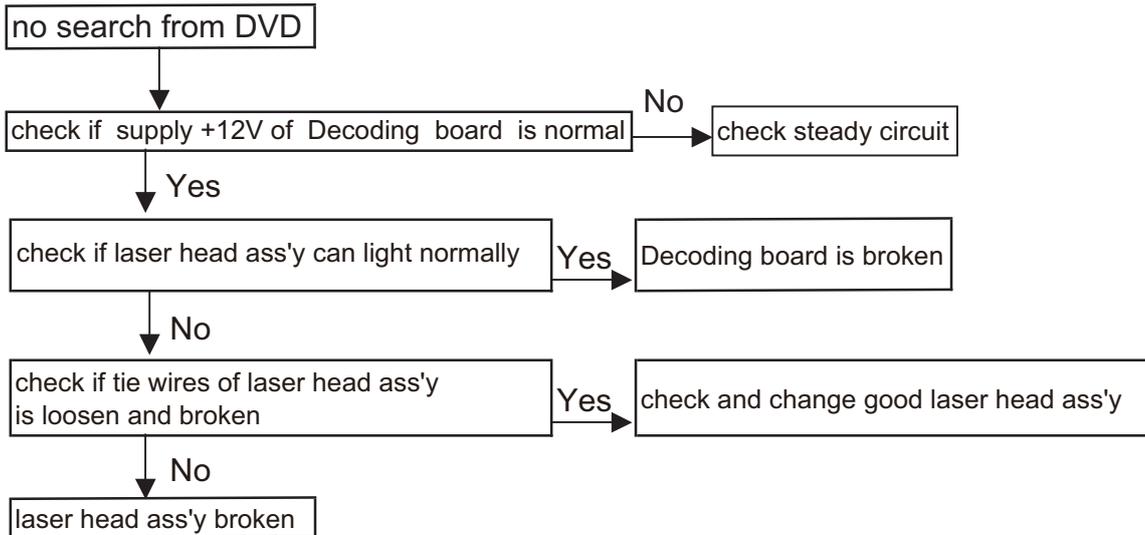
FLOW CHART NO.2



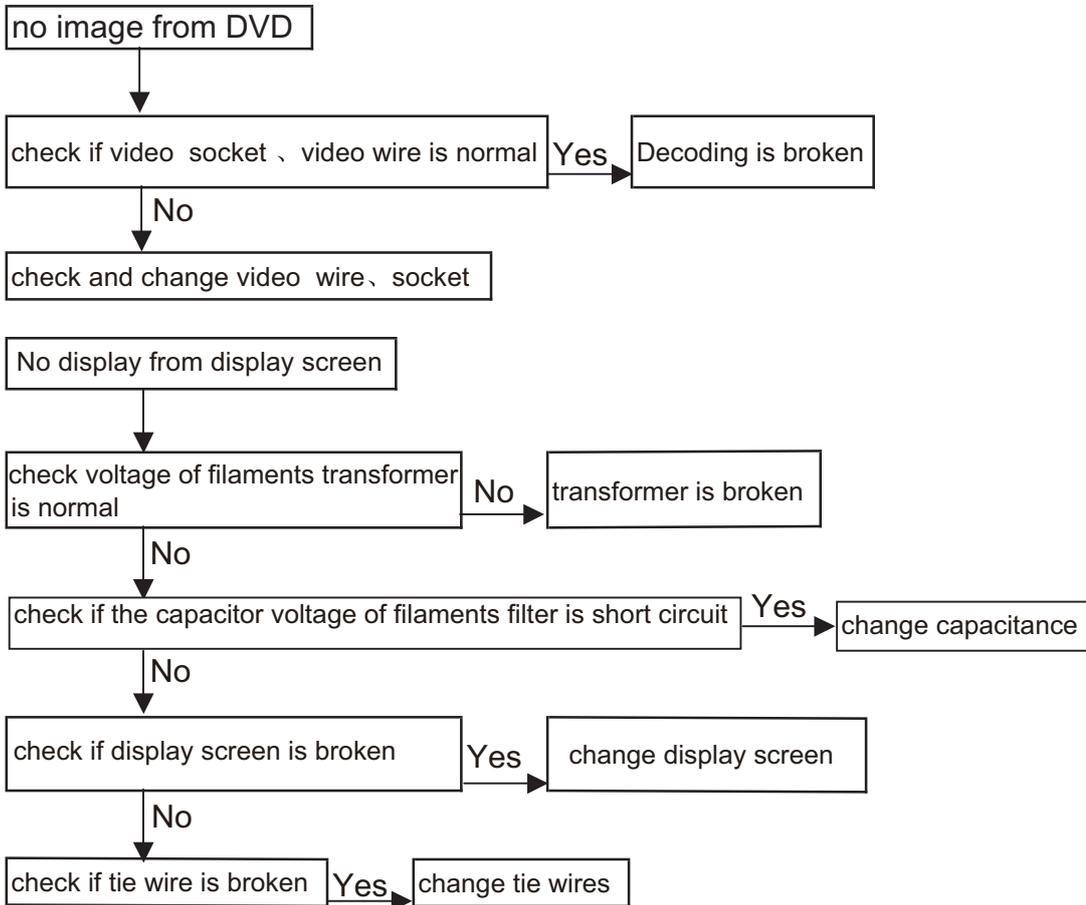
FLOW CHART NO.3



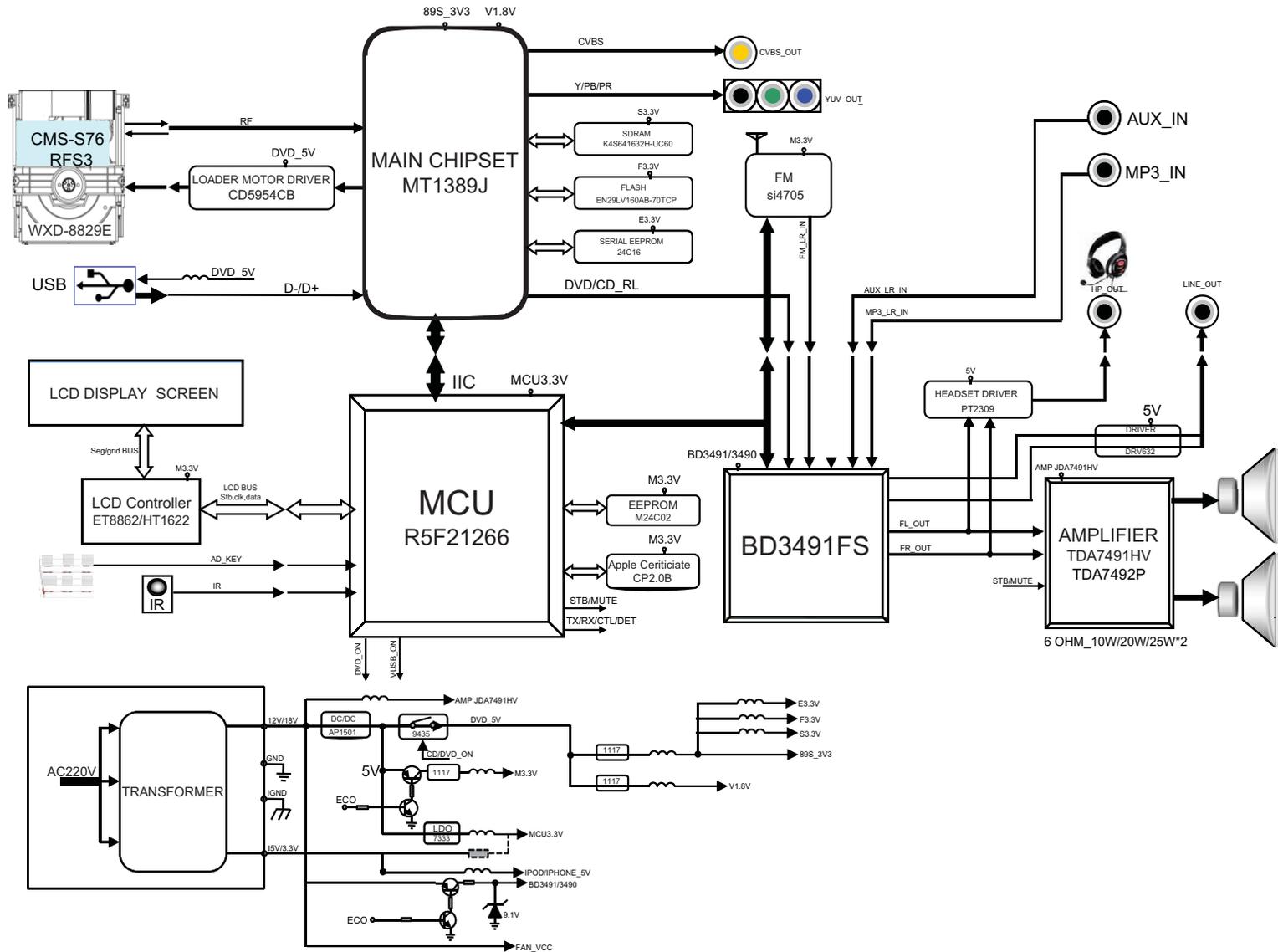
Troubleshooting



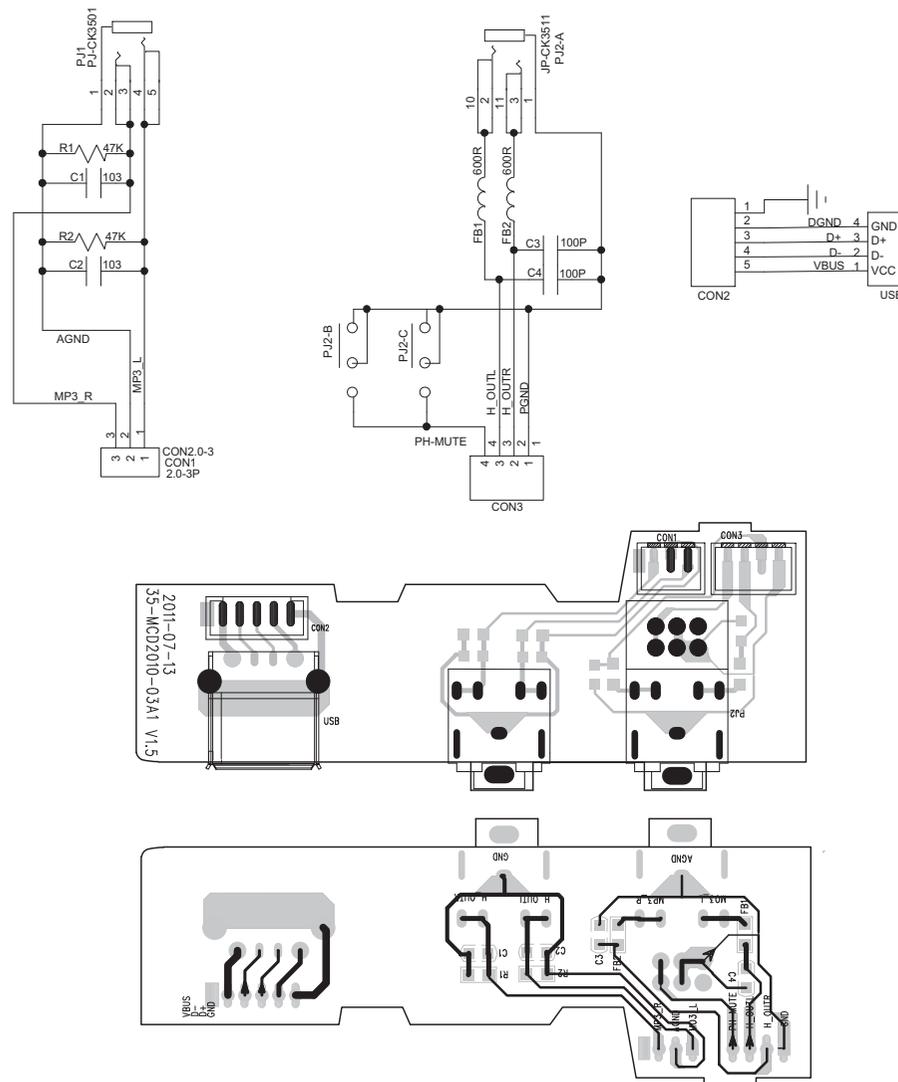
FLOW CHART NO.4



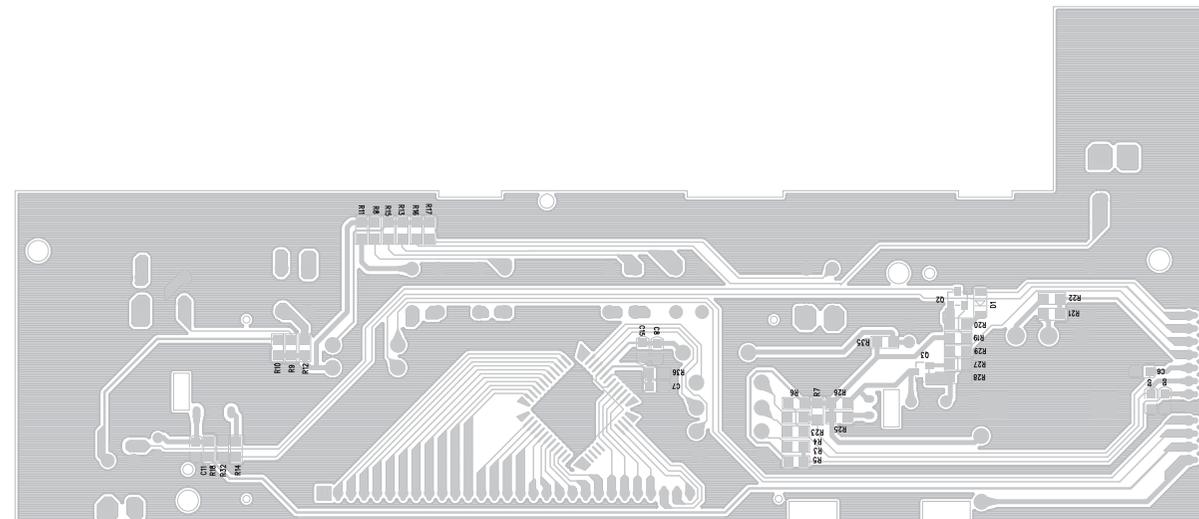
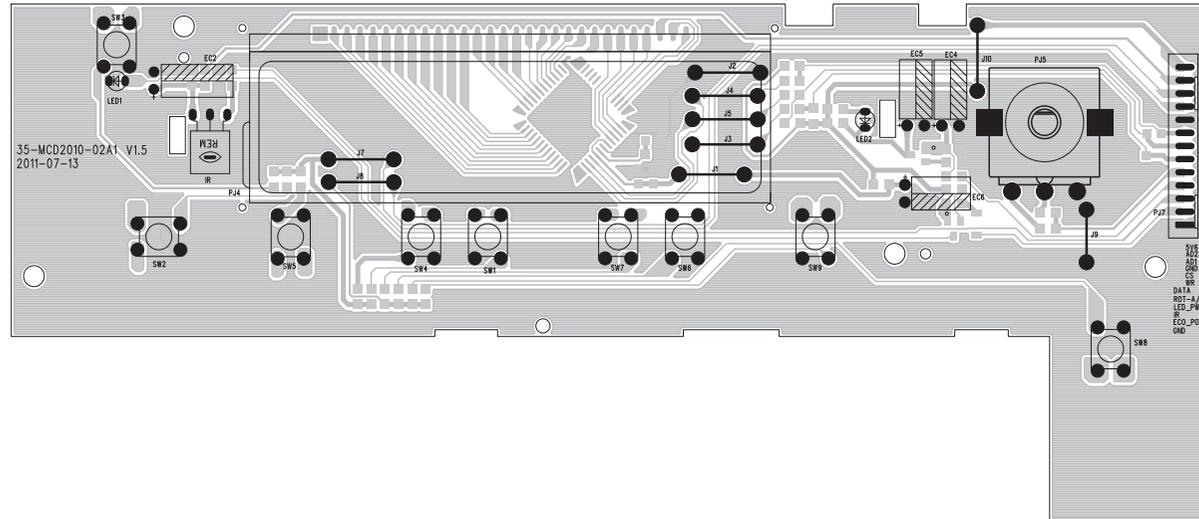
Block Diagram



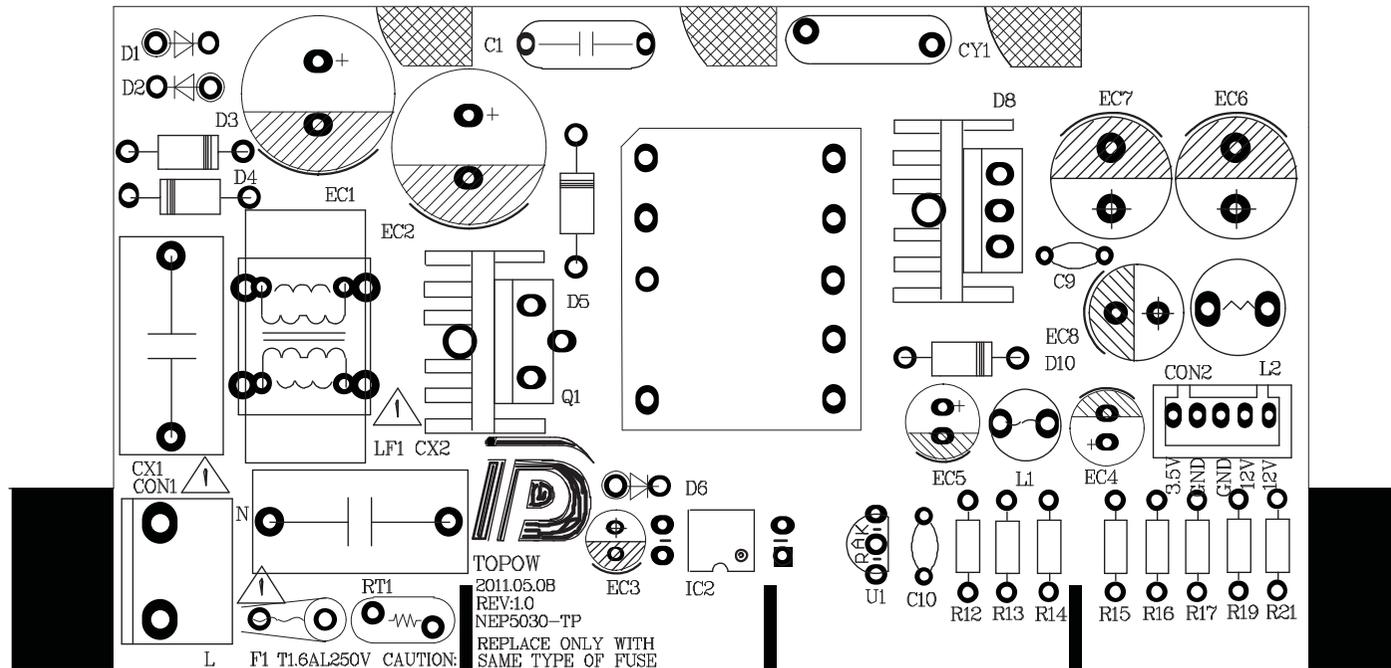
Headphone Board -- Circuit and Layout Diagram



Display Board -- Layout Diagram



Power Board -- Layout Diagram



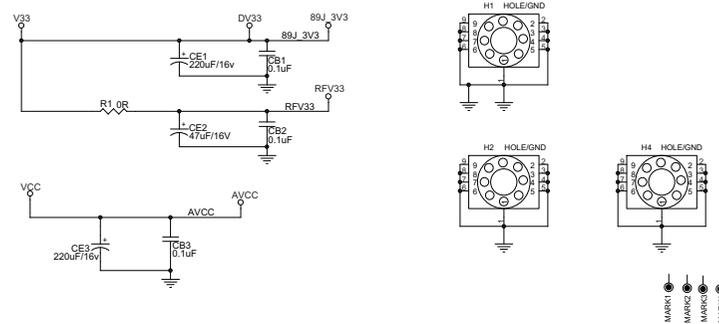
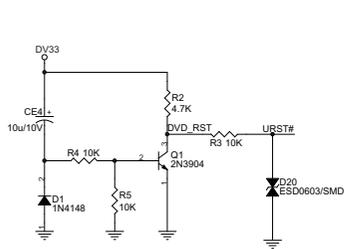
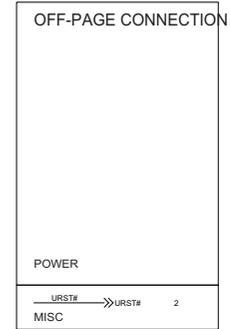
Decoder Board -- Circuit Diagram 1

COMMON1389J_HD850_AM5888_STBY
 MT1389J DVD Board w/ Sanyo HD6x Series PUHs

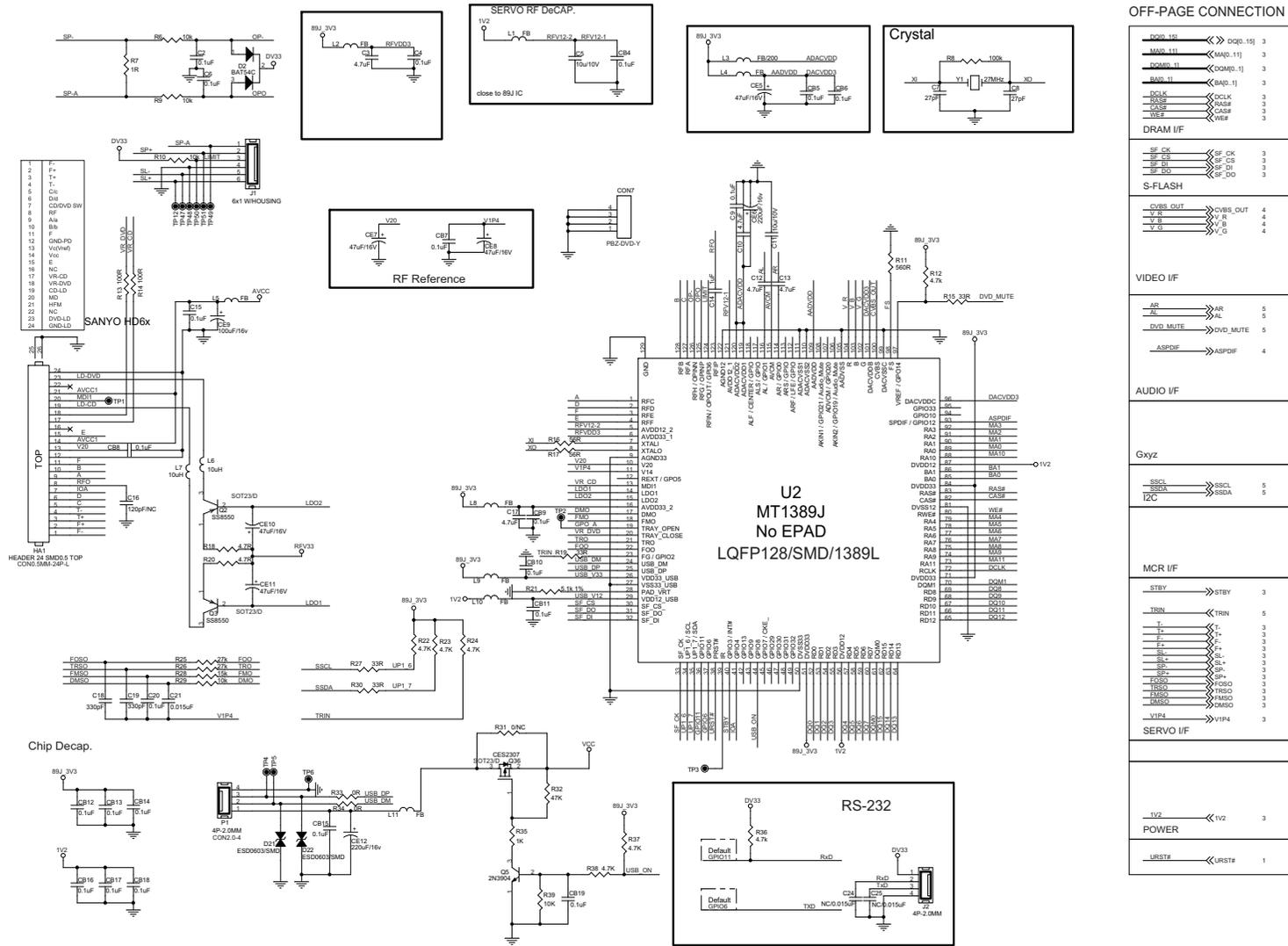
- 1 INDEX & POWER / RESET
- 2 MT1389J LQFP128
- 3 SDRAM & FLASH & MOTOR
- 4 AUDIO & MIC I/F
- 5 Video I/F
- 6 MCR & USB & GXYZ I/F
- 7 Power Flow

MT1389J General GPIO List

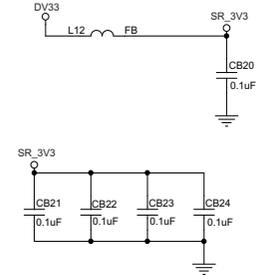
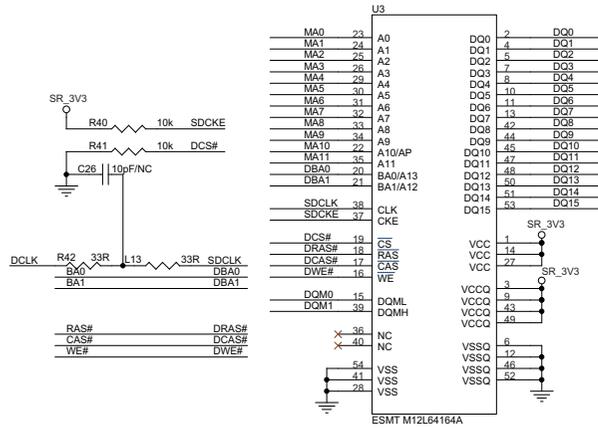
Name	PIN	Features
GPO5	12	TRCLOSE
MDI1	13	VR_CD
GPO_B	20	VR_DVD
GPIO2	23	TRIN
UP1_6	34	VSK
UP1_7	35	VSDA
GPIO11	36	Power Key RXD
GPIO6	37	SD_D0 TXD
GPIO3	40	STBY
GPIO4	41	TROPEN IOA
GPIO13	42	VSTB
GPIO9	43	MS_D0 SD_CMD
GPIO8	44	MS_BS SD_CLK
GPIO7	45	MS_CLK
GPIO29	46	Gxyz_LOAD
GPIO30	47	Gxyz_CLK
GPIO31	48	Gxyz_DA1
GPIO32	49	Gxyz_DA2
GPIO12	93	ASPDIF
GPIO10	94	SCART1 HSYNC
GPIO33	95	SCART2 VSYNC
GPO14	97	AUDIO_MUTE
GPIO19	106	AKIN2
GPIO20	107	ADVCM
GPIO21	108	AKIN1
GPI36	124	LIMIT TROUT



Decoder Board -- Circuit Diagram 2

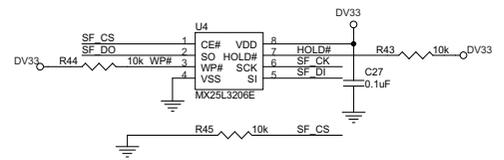


Decoder Board -- Circuit Diagram 3



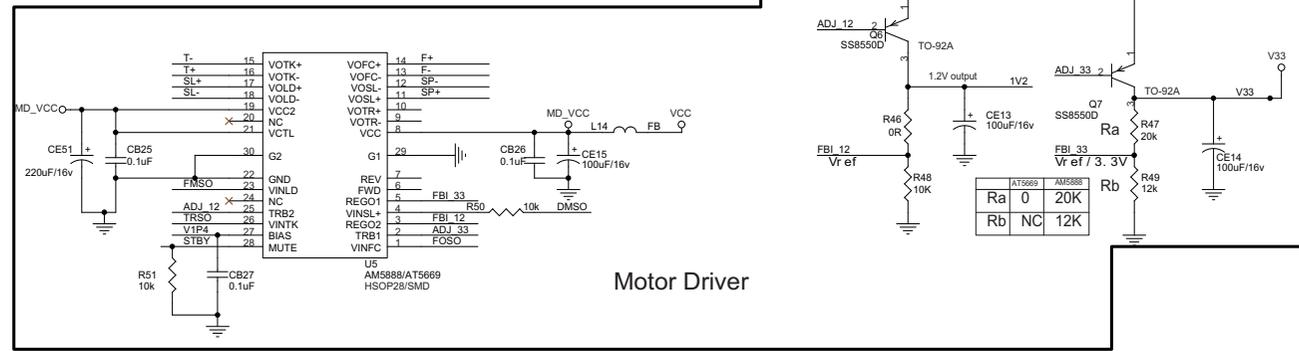
SDR_DRAM (Dual Layout)

Serial Flash



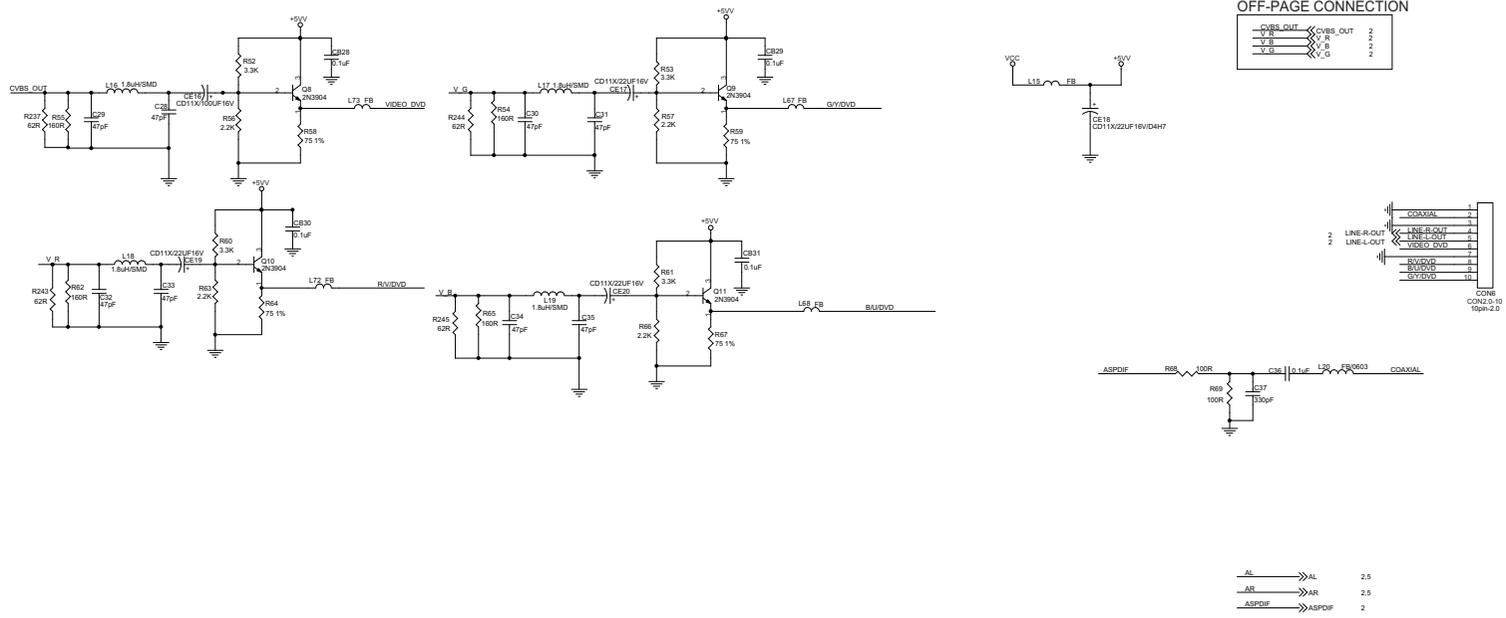
OFF-PAGE CONNECTION

DO[0..15]	DO[0..15]	2
MA[0..11]	MA[0..11]	2
DQM[0..1]	DQM[0..1]	2
BA[0..1]	BA[0..1]	2
DCLK	DCLK	2
RAS#	RAS#	2
CAS#	CAS#	2
WE#	WE#	2
DRAM I/F		
SF_CK	SF_CK	2
SF_CS	SF_CS	2
SF_DI	SF_DI	2
SF_DO	SF_DO	2
S-FLASH		
STBY	STBY	2
TRIN	TRIN	2.5
T-	T-	2
T+	T+	2
F-	F-	2
F+	F+	2
SL-	SL-	2
SL+	SL+	2
SP-	SP-	2
SP+	SP+	2
FOSO	FOSO	2
TRSO	TRSO	2
FMSO	FMSO	2
DMSO	DMSO	2
V1P4	V1P4	2
SERVO I/F		
IV2	IV2	2
POWER		

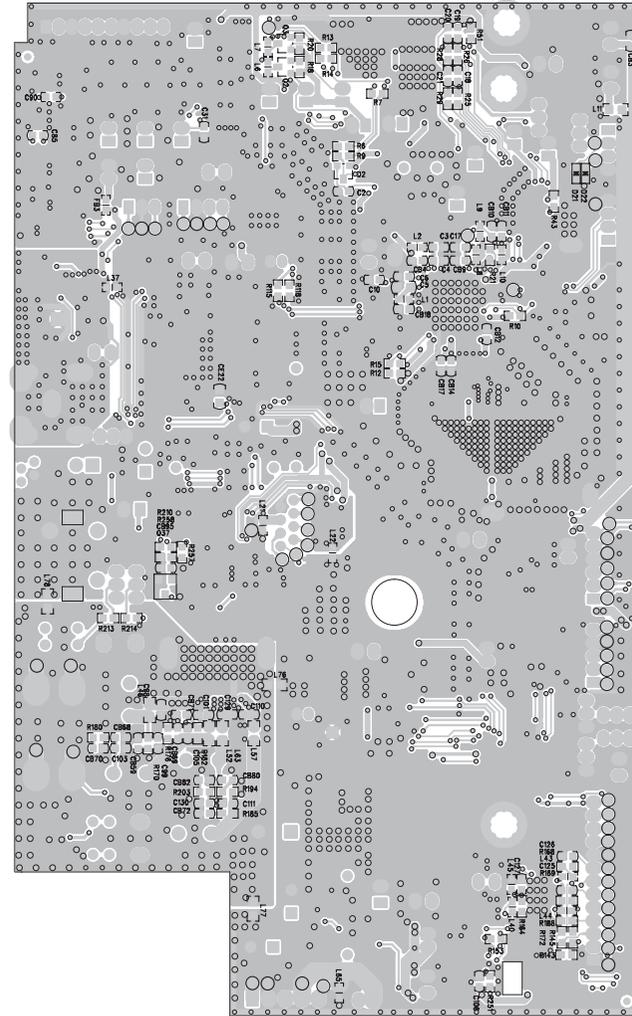
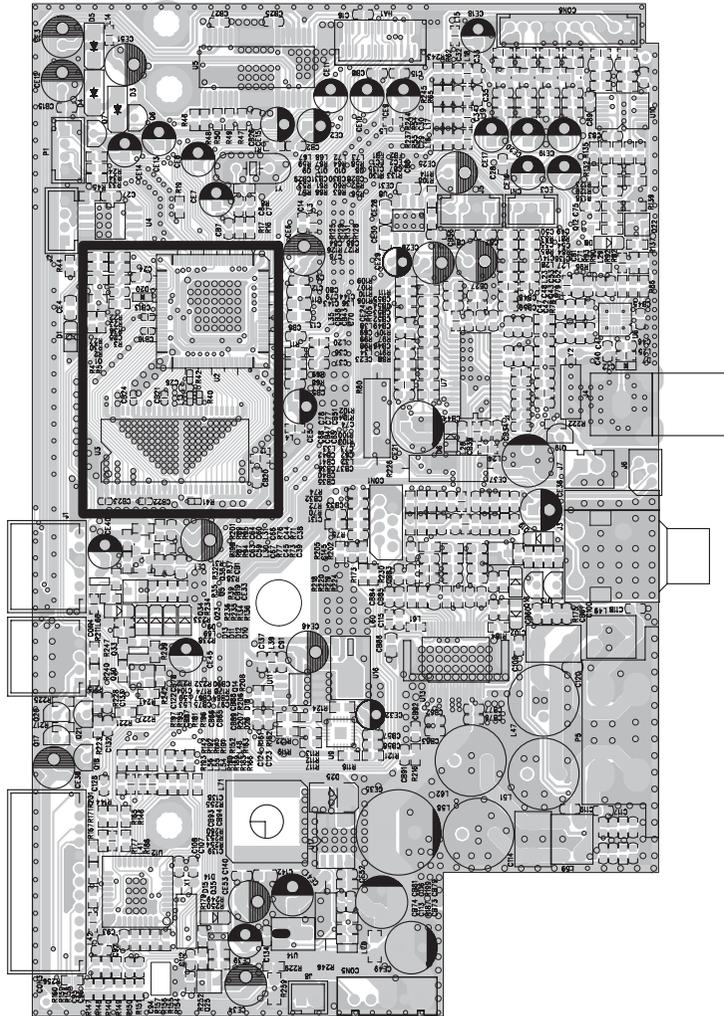


Motor Driver

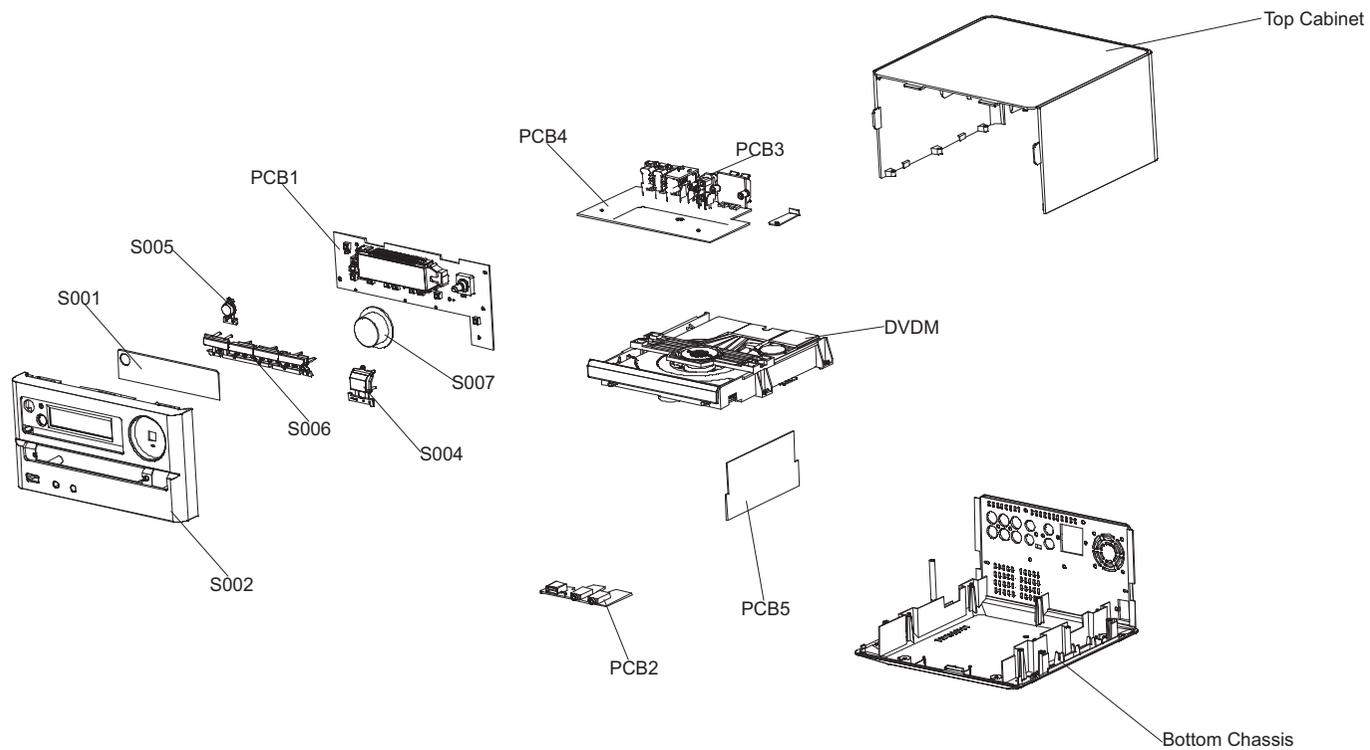
Decoder Board -- Circuit Diagram 4



Decoder Board -- Layout Diagram



Exploded View



Revision List

Revision List

Version 1.0
* Initial Release